At $2995, this signal generator costs less than those costing half as much.

Not everyone needs the performance of our 1003 Standard-Signal Generator. But those who do need it lose money if they settle for anything less. Why? Because the stability, accuracy, and resolution of the 1003 are as much as an order of magnitude better than those of any other instrument in the 67 kHz-to-80 MHz frequency range. It has motorized tuning, programmability, convenient 2-to-1 range switching, fast settable, and limited sweep capability, to name a few operating conveniences. These are all features that enable you to make measurements faster. In applications where hundreds of measurements are made daily, the cost of measurement time saved with a 1003 mounts rapidly. That's why the initial cost of the 1003 becomes less significant as you take a closer look at the "big picture."

Here are a few specific examples of how the 1003 can produce real savings:

- The motorized tuning and programmable frequency selection of the 1003 can cut measurement time in half. On a one-shift, production-line basis (at a $3 per-hour wage) this amounts to savings of $12 per day... $60 per week... over $3000 per year.
- The high resolution and stability (1 ppm per 10 min., typically) in the face of range switching, rf level adjustments, and load variations mean you don't have to buy a counter to set and monitor frequency. If you're already using a $2500 counter, the 1003 frees it for use elsewhere.
- The 1003 is virtually unaffected by power-line fluctuations; frequency will vary less than 1 ppm as a result of ±10% line-voltage changes. You don't have to buy a voltage regulator, so you save money.
- All solid-state circuitry means a cool-running instrument that consumes little power and is not as likely to break down as a tube-type instrument. Low downtime means you save money.
- Warmup drift is low and of short duration, so the instrument is usable at 8:15, not 9:00 A.M. You waste little time, so you save money.

We could go on and on with how and why this instrument performs the way it does, but you have to put the 1003 through its paces yourself to appreciate fully its convenience and performance. So why not do just that? Write or call the GR Sales Office nearest you for the loan of a demonstrator and evaluate the 1003 yourself. There's no cost or obligation. For more information on the 1003, write or call General Radio Company, W. Concord, Massachusetts 01781; telephone (617) 369-4400, in Europe: Postfach 124, CH 8034, Zurich 34, Switzerland.

GENERAL RADIO

Circle 900 on reader service card
A lot of noise in your system won't faze the Hewlett-Packard 2402A Integrating DVM. It measures low-level signals buried in noise without even slowing down. No more sacrificing speed for accuracy, no more tolerating preamp errors and delays.

The 2402A is an unequalled combination of speed, accuracy and noise immunity in a single package. With it, you can make 5-digit measurements 43 times a second, resolving down to a microvolt with full-speed accuracy of 0.01%. That's lab accuracy at system speed, even in noise that would slow active-filter DVM's to a virtual halt. BCD output and full programming are standard, and AC, ohms and frequency are plug-in options.

For complete details on how to get both accuracy and speed in the same system, call your local HP field engineer. Or write Hewlett-Packard, Palo Alto, Calif. 94304; Europe: 1217 Meyrin-Geneva, Switzerland.
Looking for Fast, High Volume AC and DC Calibration Capability?

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Easier said than done

To the Editor:

The letter "Voicing the case for ssb" [Sept. 2, p. 4] urges "that both a-m and f-m be phased out for all person-to-person voice transmission."

However, the land mobile section of the Electronics Industries Association, in an effort to determine what modulation methods make optimum use of the electromagnetic spectrum allocated for voice communications, has investigated and rejected single sideband as a means of better utilization.

The EIA report observes that "suppressing the carrier and transmitting only one sideband has long been a favored method of reducing
Something **New** Has Been Added!

**Improved** **SPRAGUE MONOLYTHIC**

**CERAMIC CAPACITORS**

now have a phenolic terminal base

Type 7C Radial-lead Capacitors are made with alternate layers of sprayed ceramic dielectric material and screened metallic electrodes, fired into a solid homogeneous block and coated with a tough phenolic resin. Their new bossed terminal base construction provides these advantages: (1) No resin run-down on leads. (2) Uniform lead spacing is automatically maintained. (3) No dirt and moisture entrapment; degreasing fluid flows freely between capacitor and board.

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<tr>
<td>082</td>
<td>N030</td>
<td>–55 C to +125 C</td>
<td>–30 ppm °C, ±30 ppm °C</td>
<td>50 100 200</td>
<td>0.024 µF</td>
<td>±20% ±10% ±2% ±5%</td>
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<tr>
<td>075</td>
<td>N750</td>
<td>+25 C to +85 C</td>
<td>Meets MIL-C-20 Char. UJ</td>
<td>50 100 200</td>
<td>0.01 µF to 0.082 µF</td>
<td>±20% ±10% ±9% ±5% ±2%</td>
</tr>
<tr>
<td>067</td>
<td>WSR</td>
<td>–55 C to +125 C</td>
<td>–750 ppm °C, ±1200 ppm °C</td>
<td>50 100 200</td>
<td>0.0018 µF to 1.5 µF</td>
<td>±20% ±10% ±10% ±2%</td>
</tr>
<tr>
<td>023</td>
<td>ZSU</td>
<td>+10 C to +85 C</td>
<td>+52%, –56%</td>
<td>50</td>
<td>0.01 µF to 3.3 µF</td>
<td>+80%–20% ±20% ±20%</td>
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**CAPACITORS**

**TRANSISTORS**

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Trenton, New Jersey 08602

Circle 6 on reader service card
bandwidth in point-to-point services and where impulse noise is seldomly encountered.” It’s the point-to-point and impulse-noise parameters that are significant in that statement. Give an operator a “clarifier” to fine-tune the receiver and the articulation index will improve; but imagine a busy dispatcher fine-tuning every mobile-to-base transmission, or a police officer fine-tuning during a chase to compensate for Doppler shift.

The tests performed by the EIA show that when impulse noise is introduced, ssb covers less than half the range that can be covered by the equivalent primary-power narrowband f-m (NBFM) system, meaning that more or higher-power ssb transmitters would be required to cover the equivalent NBFM area. It goes without saying that ssb receivers would require noise blankets as standard equipment for vehicular communication. The EIA also showed that ssb systems experience adjacent-channel interference at greater distances than do NBFM systems. In other words, ssb systems require greater geographic spacing than NBFM systems for the same frequency spacing—a factor in direct contradiction with the need for more ssb transmitters to overcome the impulse-noise problem.

For these primary reasons, it is highly unlikely that both a-m and f-m will be phased out for all person-to-person voice transmission.

R.T. Buesing
General Electric Co.
Lynchburg, Va.

Vested altruism
To the Editor:
Certainly the electronic component manufacturers that have established facilities in the Far East (July 22, p. 31 and Sept. 30, p. 31) were drawn to the area primarily by the abundance and low cost of local labor. And it's true that the hourly figures for workers are 13 cents in Taiwan and 20 cents in Hong Kong. But these figures are "unloaded" and carry the unfortunate connotation that American industry is internationally exploitative. Loading not only makes the costs involved more realistic, but brings to light something frequently overlooked. For lack of a better phrase, I call it "vested altruism."

As an example, the girls on Fairchild Semiconductors' Hong Kong assembly line receive an excellent luncheon as part of their compensation. I recall hearing the marketing director at Fairchild say, "The meal was so good and their work environment so much better than their home conditions that a significant problem was getting the workers to leave after their shift."

I think an informal survey of the Hong Kong facilities of other U.S. corporations would yield further support for my belief that companies operating overseas are not easily categorized as latter-day Simon Legrees. Further, I believe that our vested altruism is sincere and will most probably increase.

Ricardo J. Alfaro II
Vice president
Ness Industries Inc.
Palo Alto, Calif.

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Write for our catalog of radio, microwave and multiplex equipment, accessories and services.

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Electronics | November 25, 1968

Circle 7 on reader service card
Is Your Budget Too Tight For Your Bandwidth?

$284

Try this one for size—Data Instruments Model 555. For any application, Production Line, Field or Laboratory, this scope is a perfect fit. Look at what it offers: (1) Performance. A 7 MHz bandwidth, and an extremely linear time base with variable controls over 19 calibrated ranges and a variety of triggering modes. (2) Display. A 5 inch Braun type tube with an edge lit, removable graticule provide highly precise and legible traces on an 8 x 10 centimeter viewing area. (3) Reliability. All attenuators are solid state and fully compensated. Backing up this solid state reliability is a full year’s warranty and complete field and factory service.

Examine the specifications.

<table>
<thead>
<tr>
<th>VERTICAL AMPLIFIER</th>
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<tr>
<td>BANDWIDTH</td>
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<tr>
<td>DC-7 MHz</td>
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<tr>
<th>TIME BASE</th>
<th>CRT</th>
<th>PHYSICAL</th>
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<tr>
<td>SWEEP/CM</td>
<td>HORIZONTAL AMP.</td>
<td>DIA.</td>
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<td>1µs-1 sec.</td>
<td>Exp. X5</td>
<td>5&quot;</td>
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<tr>
<td>(19 ranges)</td>
<td>20Hz-7MHz</td>
<td>2Hz-200kHz</td>
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Look at the scope in action. Drop us a note and we'll arrange a demonstration in your plant. You'll find the 555 fits your bandwidth requirements comfortably. At $284 its very comfortable indeed.

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First impressions of microwaves for Vernon E. Dunn came when he worked with radom installations as an ROTC man at Wright-Patterson Air Force Base. These impressions must have been strong; they led eventually to a Ph.D. dissertation at Stanford University on microwave pulse-compression filters. Dunn, author of the circulator article on page 84, also earned his BSEE and MSEE at Stanford and worked in the systems techniques lab there. He's been at Melabs since 1962, working in several microwave areas, and now heads the microwave advanced development group. A major interest at the moment is the application of thin-film techniques to the fabrication of ferrite devices. He sees thin-film microstrip circuitry as the wave of the future in the production of ferrite devices. Dunn, the father of three children, turns to photography for relaxation.
Airplanes, not corridors, take Thomas J. Thomas from one "office" to another. Thomas probably spends almost as much time flying from one coast to another as he does behind a desk; he splits his time between his headquarters in Little Falls, N.J., and his company's manufacturing facility in San Marcos, Calif. He's still spending a great deal of time on the automated production line he describes in the article on page 88.

Thomas is senior vice president for avionics of the Kearfott Products division of Singer-General Precision Inc. He's been with Kearfott since 1951, and as a design engineer has worked on such projects as navigational computer systems, precision-stable platforms, analog-to-digital converters, and navigational display instruments. He holds a BS from Pennsylvania State University and an MS from Stevens Institute of Technology.

The special report on face-down bonding techniques on page 72 was put together by Lawrence Curran, Electronics' Los Angeles bureau manager. Inputs came from Walter Barney and Peter Vogel in San Francisco, James Brinton in Boston, William Arnold in Washington, and William Bucci and George Watson in New York. Curran, who has chalked up nearly two years in Southern California for Electronics, began his investigation of bonding methods in August.

Your custom pulse transformer is a standard DST* transformer

You can select the transformer design you need from the new Sprague DST Family, a fully-characterized series of Designer Specified Transforms which Sprague Electric has pioneered. It's easy. Start with the two basic parameters dictated by your circuit requirements: primary (magnetizing) inductance and volt-second capacity.

New Sprague engineering data gives basic information from which all nominal sine wave parameters are derived. This data allows you to specify the one transformer from thousands of possibilities which will optimize performance in your application.

Design Style A minimizes magnetizing inductance change as a function of temperature. Typically it's < ± 10% change from 0 to 60°C; < ± 30% from −55 to +85°C.

Design Style B and C give you broad bandpass characteristics, and still keep magnetizing inductance change < ± 15% from 0 to 60°C.

Design Style D is fast. Associated leakage inductance and coupling capacitance are kept at a minimum. This style is just what you need for interstage and coupling devices in computer drive circuits.

The Sprague DST Series packs a lot of transformer into minimum volume packages — epoxy dipped for minimum cost, or pre-molded. The 100 mil in-line lead spacing is compatible with integrated circuit mounting dimensions on printed wiring boards.

Our Hybrid Hunters are looking for you!

A letter contract which it is anticipated will result in a multi-million dollar agreement calling for manufacture of seven types of integrated circuits (IC’s), for use in the United States Navy’s Poseidon program, has been awarded to Philco-Ford Corporation’s Microelectronics Division by the Lockheed Missiles and Space Company, Sunnyvale, California.

"The contract’s value is expected to exceed $5 million over an 18-month period," said Howard T. Steller, Microelectronics Division General Manager, in announcing the award.

Poseidon is the newest missile being developed for the United States Navy Fleet Ballistics Missile System. Lockheed is prime contractor.

The seven types of IC devices Philco-Ford will supply are five IC’s with diode-transistor logic (DTL), a Model 709 operational amplifier, and a Lockheed-designed IC.

Mr. Steller pointed out that this award, expected to exceed $5 million, is the second major order recently received by the Microelectronics Division. The Division was selected to be one of three firms to share in a Burroughs Corporation order for IC’s, believed to be the largest order ever placed in the semiconductor industry for standard devices.
Take the solid-state route to >1 watt CW output in $K_u$ band!

Cash in on the simplicity and compact size of the Philco P8007 Solid-State Power Source. It delivers more than 1 watt of spectrally clean, stable CW power at 13.3 GHz.

What's the secret of its success? Philco L8500 Series Silicon Integrated Varactors do the job of frequency multiplication. Their unique design, using series-connected silicon varactor chips bonded to a high thermal conductivity substrate, produces power handling capability nearly an order of magnitude greater than conventional varactors.

Supplied in standard microwave packages, they only need heat sinking at one end. Use of the single substrate technique results in the lowest thermal resistance values available in the industry. Cutoff frequencies up to 300 GHz can be provided.

We can supply proven Silicon Integrated Varactors to assemble into your own microwave power source. Or, we can take on the entire job and deliver the best high-power, solid-state power source you've ever seen.

<table>
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<tr>
<th>Capability of Philco Silicon Integrated Varactors:</th>
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<tr>
<td><strong>Type</strong></td>
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<tr>
<td>L8505</td>
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<tr>
<td>L8504</td>
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<tr>
<td>L8503</td>
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<td>L8512</td>
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<td>L8513</td>
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**Spectral Characteristics of Philco P8007**
- Frequency stability: ±10 ppm long term
- Spurious outputs: more than 40 db below carrier
- AM noise: -120 db typical at 1 KHz (100 Hz bw)
- FM noise: 6 Hz at 10 KHz (100 Hz bw)

Dielectrically Isolated IC's Now Available

The conventional technique for isolating components of an integrated circuit—reverse biased P-N junctions—has some inherent shortcomings, one of which is high sensitivity to transient radiation.

The urgent need for radiation tolerant systems has spurred development of dielectrically isolated integrated circuits in recent years. Philco-Ford is a leader in this technology. We have developed a reliable process for making IC's in which isolation is obtained by fabricating each component in a "tub" of silicon dioxide. Radiation-induced currents of catastrophic magnitude are thereby prevented from flowing throughout the die.

We are currently in position to supply prototype quantities of a selection of dielectrically isolated DTL devices, including gates, buffers and flip-flops. We're ready to consult with you on your specific application.

Industrial Cerdip DTL with MIL hermeticity... at new low prices

Performance. Economy. Immediate delivery. These are good reasons to put Philco-Ford Cerdip DTL to work in your equipment.

If you're using flat packs now, consider this: Cerdips are far more convenient to stock, handle and connect. They're ideally suited for automatic insertion and soldering techniques.

And when you buy from Philco-Ford, you can be confident that quality and reliability are proved by exhaustive qualification testing, and assured by the most painstakingly thorough inspection procedures in the IC business.

If you've looked on Cerdip as the high-priced package, turn your thinking around. Our industrial Cerdips carry new low price tags. They're immediately available for quantity shipments.

And they're ideal for MIL breadboards.
New Computing Expressway

DIRECT ACCESS TO ALL AREAS
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Program from the keyboard. Record and store 196-step programs on credit-card-size magnetic cards for repeated use.

Designed for expansion. Printer, plotter, electrical data input/output will become available.
Who's who in electronics

"They all laughed at Christopher Columbus" could well be Riccardo Vanzetti’s favorite song after three jobs and nearly 15 years of trying to get his ideas on infrared component testing accepted. Far from getting discouraged, however, Vanzetti has founded his own firm, Vanzetti Infrared & Computer Systems Inc., to do the work nobody else seemed interested in.

Vanzetti became interested in i-r during his mid-50’s work at the Fisher Radio Co. in New York when he saw a technician checking resistors with a wet finger. "This fellow said he could adjust bias on electron tubes just by feeling hot resistors; if he could do that, I thought, I should be able to take infrared photos to detect overheating components," he says.

It turned out that he could, but Fisher didn’t take the idea seriously, so Vanzetti went to the American Bosch Arma Corp. (now called Ambac Industries), which was then developing control and guidance computers.

Two systems. Though Vanzetti had some thoughts about spotting flaws by placing i-r-sensitive overlays on computer circuit boards, his ideas struck out at Bosch, just as they had at Fisher. So he surveyed the industry "for the best deal I could get. Finally, I picked Raytheon."

Some of his effort as Raytheon’s manager of i-r techniques and systems was used in the development of Compare, an automated system for making i-r profiles of circuit boards, and in an i-r profile method of testing integrated circuits [Electronics, April 3, 1967, p. 100].

He left Raytheon, he says, because "I wanted to work on recombination radiation." Recombination radiation, in the near i-r spectrum, is a very faint emission caused as current moves through a semiconductor. "I had first written a paper on it in 1962 and had followed this with proposal after proposal—they were all turned down because no one thought such radiation could be detected. But I thought it could be detected and that it could be used to look inside semiconductors and spot modes of operation and failure."

During his last year at Raytheon, Vanzetti finally succeeded in getting a NASA contract on "transient radiation in semiconductor materials." "They called it transient radiation because recombination radiation couldn’t be detected and ‘everybody’ knew it. Nobody would have approved a study on recombination." But Vanzetti detected it (see story on p. 51) late last spring before leaving Raytheon.

"Raytheon’s management didn’t want to invest in an infrared instrumentation line," he says. "For them it would have been small potatoes—only about $12 million or so by 1973 or 1974."

Sweet sorrow. So Vanzetti and Raytheon parted friends. "For a while, they were even looking for a firm to employ me and let me work full time on infrared, but on Oct. 1, I struck out on my own."

"Recombination is going to be as important to the development of solid state devices as the oscilloscope was to tube technology," he says. "Now for the first time we can study the behavior of carriers in, say, a small part of a junction—this is a very intimate tool."

He notes, "And I’m happy finally to have an employer who will let me work full time on i-r."

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Take a long look at the Abbott line of over three thousand standard models with their prices listed. The unit shown above, for instance, is the Abbott Model AL6D-27.6A, a DC to DC converter which puts out 28 volts of regulated DC at two amps and sells for only $220.00. Other power outputs from 5 to 240 watts are available with any output voltage from 5 volts to 10,000 volts, all listed as standard models in our catalog. These converters feature close regulation, short circuit protection, and hermetic sealing for rugged application found in military environment.

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Abbott manufactures a wide variety of different types of power supply modules including:

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Who's Who in electronics

Jennette

Center, is now taking shape in Gaithersburg, Md. The managerial structure is also taking shape. The most recent appointment: Joseph E. Jennette Jr., 36, who will be the assistant general manager at the center.

Jennette, an electrical engineer, has the reputation at IBM of being one of its top men in contracts and marketing. At the Electronics Systems Center in Owego, N.Y., Jennette handled the business side of the highly successful 4-pi airborne digital computer. Under his direction the 4-pi was picked for major military systems, including the Manned Orbiting Lab and the Mark 2 avionics system.

Lasers, too. Jennette, who will be guiding staff operations, says the center will develop communications devices that are not part of computer systems. "We plan to introduce a fair number of new devices next year," he says.

He points out that some of the devices will be “stand alone” items that will operate with computers but can be marketed independently, while others will be tied to the IBM product line. Among the items of interest: input-output devices for information systems, displays, devices to transform input from sensors into computer formats, and, in general, items to help in the establishment of digital computer communications networks.

The center will also do a lot of laser work. Jennette says, "We are interested in a host of applications for the laser—for ranging as well as detection."
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3 PRELOADED CANTILEVER CONTACTS For a low cost, high performance connector—designed especially for automatic wire wrapping—pick Amphenol's 261 Series. Cantilever contacts are confined in the dielectric to a predetermined load force. This gives you uniform pressure and positive mating action. Contacting surfaces have a minimum of 50 microinches of gold over phosphor bronze. Wire wrap capability on .100", .125", .150", .156" and .200" centers. Also, high contact density multi-board connectors for your special applications.
MODULAR PLATE ASSEMBLIES For custom designed specials at production line prices—with up to 36,000 contacts—pick Amphenol's 230 Series Snap-Wrap® or 240 Series Mini-Wrap® connectors.

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Circle 21 on reader service card
Meetings

Superficial input, superficial output

As usual, the Fall Joint Computer Conference, which will be held this year in San Francisco, Dec. 9 to 11, is supposed to be all things to all people, and therefore lacks the depth that many computer engineers might like.

The meeting's scope is illustrated by two sessions entitled, "The computer field: what was promised, what we have, what we need." One concentrates on software, the other on hardware. Unfortunately for hardware-oriented engineers, the latter is on the third day of the conference, whereas the software session is bright and early the first day. Attendance at conferences usually drops off sharply on the last day as almost everybody scurries to get started for home ahead of the rush.

Three sessions will deal with robots. One, on vision and speech, is largely software-oriented. A discussion of intelligent robots will describe primitive robot-like machines. The third, on human augmentation, is apparently intended to answer the question, what good are robots?

An exception to the usual kind of discussion is a one-man session at which Douglas Engelbart of the Stanford Research Institute will expound on his ideas for expanding human intellectual processes with computers.

For more information write AFIPS, 210 Summit Ave., Montvale, N.J. 07645

Down from the ivory tower

By their very nature, conferences on circuit theory have an ivory-tower quality about them, stressing mathematics and pure science but ignoring practical applications. They generally attract local college professors and researchers—not circuit designers. Yet their image may be changing. The 1968 IEEE International Symposium on Circuit Theory—Dec. 4 to 6 in Miami Beach—will pay as much attention to the practical as to the theoretical and will be attended by representatives of both industry and universities around the world.

Heavy emphasis has been given to selecting papers that offer either solutions to problems or at least a means of attacking them. Computer-aided design of circuits and systems will be investigated, for example, and two panel discussions on the subject are planned. The conference will look into the shortcomings of current computer programs and offer suggestions about the direction future CAD programs should take.

The problems of optimizing large-circuit designs and distributing electrical power will receive similar treatment, as will the area of communications, particularly digital. For instance, A.G. Constantinides of the City University, London, will present a paper on digital filters with equiripple passbands—devices of particular interest because they can be built with inexpensive, mass-produced digital gates.

Filter tips. Several of the scheduled papers will be devoted to active-filter design. One of them, "Synthesis of Microstrip Transmission Networks Utilizing Semiconductor Dielectrics," by A.W. Cuiwik of Bell Labs and J.H. Muligan of New York University, will describe how to build a distributed IC network that can operate at high frequencies. Also, Dan Hilberman of Bell Labs will discuss active network synthesis using non-zero-gain amplifiers, and C.K. Kuo and K.L. Su of the Georgia Institute of Technology will offer a paper on the synthesis of negative-impedance converters and negative-resistance networks.

All the papers in the active-filter field will concentrate on achieving (Continued on p. 24)
A Communications System Test Set (VLF to HF)...

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Meetings

(Continued from p. 24)

Information Sciences, University of Florida; Gainesville, Dec. 17-21.

American Association for the Advancement of Sciences; Dallas, Dec. 26-31.

Symposium on Reliability, IEEE; Palmer House, Chicago, Jan. 21-23.


Short courses

ECAP Workshop (Electronic Circuit Analysis Program), University of Wisconsin, Madison, Jan. 27-28; $70 fee.

Theory and Design of Reliable (Fault-Tolerant) Computers: Protective Redundancy, Diagnosis, Self-Repair Engineering, University of California, Los Angeles, Jan. 6-17; $375 fee.

Computer Aided Circuit Design, George Washington University, Washington, Jan. 6-10; no fee.

Call for papers

Biomedical Sciences Instrumentation Symposium, ISA and the University of Michigan; Chrysler Center, University of Michigan, Ann Arbor, May 19-21. Dec. 15 is deadline for submission of abstracts to 1969 BSIS Technical Program Committee, c/o Ernest E. Sellers, chairman, Box 618, Ann Arbor, Mich. 48107

Conference on Electric Fields in the Magnetosphere, American Geophysical Union and Rice University; Rice University, Houston, March 10-13. Jan. 6 is deadline for submission of abstracts to Prof. J.W. Freeman Jr., Department of Space Science, Rice University, P.O. Box 1892, Houston.

Nuclear Electronics Symposium, IEEE; Ispra, Italy, May 6-8. Jan. 10 is deadline for submission of abstracts to Prof. Luciano Stanchi, C.C.R. Euratom, 21020 Ispra.
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1. Unlighted Pushbutton Switches. Bushing or bracket mounted. Available in 1-, 2-, 3- or 4-pole double-throw circuitry, momentary or alternate-action. Black, red and green buttons in various diameters. Sealed designs available. Wide range of electrical power-handling capabilities.

2. Series 2C200 Modular Lighted Pushbutton Switches. Rectangular display lighted by projected or transmitted 4-lamp color. Can be relamped without tools. 1, 2, 3 and 4 section split-display screens. Maintained, momentary or magnetic hold-in operation. Switch modules with silver or gold contacts, multiple circuits and broad choice of contact arrangements and electrical capacities. Also reed switch module.

3. PT Heavy-duty and CMC Pilot-duty Industrial Manual Controls. Oiltight pushbuttons, selectors and indicators with the modern square look. Lighted or unlighted. Large easy-reading legends. Multi-circuit control with up to 32 circuits per unit.

4. KB Switch/Display Matrix. New keyboard building block concept consisting of pushbuttons and pushbars (lighted and unlighted), switches, indicators, mechanical interlock units, and modular hardware for mounting and wiring. Entire KB matrix can be bench assembled. Switches can be pre-wired and plugged in like a radio tube. Milliamp-rated "encoding" switch produces a coded output for data entry, exclusive of separate circuit packages. "Power" switch with 5 amp. 115 vac rating has lighted display option.

5. 50PB Bushing Mounted Pushbutton Switches. One-lamp indication. Choice of button sizes, shape and colors. Long and short-stroke and turn-to-hold momentary action; one- and two-level alternate-action. 1-4 pole double-throw and two-circuit double-break contact arrangement.

6. DM Pushbutton Switches: Attractive, rugged snap-in panel mount. SPDT or DPDT circuitry. Three snap-on button styles, 1/4" to 1" diameter, red or black. Also 1/2" diameter integral momentary-action and push-pull alternate action buttons. Rating: 10 amps, 125 or 250 vac; 1/2 hp, 125 or 250 vac.

7. 30PB Miniature Pushbutton Switches. One- or two-section two-lamp display. Momentary and alternate-action operation of two SPDT switches. Spacing barriers and panel seals available.

8. Series 2N Modular Lighted Pushbutton Switches. Relampable without tools, these switches feature spring-lock mounting. Molded color housings, in gray, white or black, can be supplied with terminals for two or four lamps. Modularity provides a number of circuit, operation and display possibilities paralleling the 2C200 options. Spacing barriers and hold-in coil modules are available.

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Enhancing the voice of the people

Fast vote tabulation is the least of the Election Day benefits electronics can confer. Greater participation in the democratic process—and, as a consequence, a better-informed electorate—can result from the wise application of technology to the election process.

The trend to electronics is already under way. Some 60 counties in 15 states used the IBM Votomatic (punched card) system in last month’s Presidential election. In some isolated cases, the tests fell short of expectations. In Dallas County, Texas, for example, some of the ballot cards were improperly punched due both to voter error and machine misadjustment.

In Los Angeles County, 33,000 Votomatic recorders were used in the June primaries and again in November. Transporting the cards from the 7,000 precincts to check-in and tabulating centers proved a problem in June, though the operation went smoothly in November.

But in spite of occasional troubles, such trials can be regarded as the first step toward a streamlined, nationwide voting system based on advanced data-transmission techniques.

The challenge cries out for a systems engineering approach. And it’s clear that when this approach is applied, the telephone will be considered for a role in the voting process, a role that will permit citizens to cast their ballots without stirring from homes or jobs. One possibility would be a phone set into which the voter could insert an identification card that would connect him to a central computer. If conventional telephones were used, the voter might be identified by his voice print. Although voice prints might be counterfeited, there seems little likelihood of fraud on a large scale.

Robert Stiefel, president of Infotran Inc., told a recent meeting of the Association for Computing Machinery that the best kind of automatic electronic voting system would be one that accepts a variety of inputs—voting-machine cards, mailed ballots, or telephoned votes. Such a system might encompass:

Automatic voting booths. Candidates and issues could be displayed on electronic readouts. The voter would have a personal voting card to validate his right to vote, connect him to a central computer, and permit him to cast his ballot.

Machine-readable ballots. Unit data cards such as punched cards would be mailed to eligible voters (presumably they would be prepunched to certify the individual voter’s identity). The voter would mark his card and mail or carry it to a local voting center where a machine would read and count it.

Special telephones. A modification of the subscriber’s regular phone could permit the reading of his voter identification card. Automatic checking gear such as magnetic disk files would validate the voter’s card and give him a “proceed to vote” signal. He would then dial a predetermined code to register each of his choices on candidates or issues.

Conventional telephones. Voice validation would be the logical choice in this case; voice prints have the advantage of being easily transmitted by narrow band. The prints would be accompanied by a dialed voter code.

Stiefel envisions a nationwide network of such inputs connected directly to local voting centers. These, in turn, would be connected to county, state, and Federal centers by data-transmission links. Besides encouraging wider participation at election time, the same system could be used to feed back public opinion on key issues to legislators.

Admittedly there are hazards in setting up such a system. Above all, it would have to be tamper-proof. And it would have to ensure accurate and reliable data transmission and storage, and protect the privacy of the voter. A skillful technician might be able to alter the accumulators of electronic registers without leaving a trace. Stiefel suggests such countermeasures as encrypting data at the major centers.

That accumulators can go haywire was vividly demonstrated during the Presidential election when the computer-based system serving the major television networks and wire services began to report wildly inflated counts and percentages (see “A night to forget” in Electronics Review). To avoid a recurrence, gross errors could be detected by comparing the accumulated vote with the maximum possible vote or, better yet, with the projected vote. And error detection could be carried out on a continuous basis using error coding schemes.

We agree with those observers who feel a large-scale electronic voting system is not only technically feasible, but inevitable in the very near future. One wonders which electronics firm will tackle the challenge and thereby share in a potentially lucrative market—the market for voting machines alone is estimated at $500 million. **
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CLIFTON
DIVISION OF LITTON INDUSTRIES
The military has become disenchanted with laser television displays, believing that the technology is still too crude. Instead, scientists in the three services plan to push simpler laser display technologies that can’t generate moving pictures.

The disenchantment stems from nearly two years of experiments with a feasibility system developed by Texas Instruments. That system, costing about $87,000, has suffered from one failure after another, a civilian Air Force scientist concedes. The problems have been with the two lasers (ion-argon and helium-neon types) and the modulation/deflection scheme.

“Let’s face it, it’ll be years before a really reliable high-power laser that gives us the colors we want can be built,” the scientist says. “And the electromechanical modulator/scanner design is a headache.”

Air Force scientists say informal discussions with colleagues from the other services have led to agreement that they must start searching for other technologies to produce large displays.

The search appears to be turning to screens that produce images by either reflecting light or letting it pass. One possibility would be photochromic materials whose transparency or opacity depends on whether they’ve been scanned with a laser. The laser beam could be used much like a light pen, drawing the image on the screen; the display would then be completed by back-lighting the screen. Because the screen could store the patterns, relatively few passes of the beam would be necessary to build up an image. The Air Force will soon begin material-development research for the screen.

Such a system could use a weaker laser and slower scanning than laser tv, which requires about 30 watts of c-w power and a raster that scans as quickly as the electron beam in a cathode-ray tube. Both kinds of laser systems can produce wall-size displays that can be viewed in a normally lighted room.

Several firms, apparently seeking industrial customers now that the military market has dried up, are working hard to prepare laser tv systems that have been under development for the past few years. GT&E just introduced a laser system that takes pictures directly from a tv set. A civilian Air Force engineer familiar with the system concedes that it’s an improvement over the Texas Instruments design but says, “It suffers from the same general technical problems.”

Even the giant of the computer industry appears to be developing some interest in the exploding minicomputer market, if a paper to be presented at the Fall Joint Computer Conference (see page 22), is any indication. So far IBM’s smallest computer has been the 1130, which sells for about $24,000 and up. But three researchers have built a purely experimental computer on a single 8-by-12-inch multilayer board—the same kind used by the dozens in most of the company’s computers and peripheral equipment.

The computer has only three instructions—fetch, store, and conditional branch. The designers’ aim was to build a computer with a minimum of hardware and a maximum of program. Everything is done with a table...
look-up procedure; the tables and all information for timing and data manipulating, as well as the instruction stream itself, are kept in the memory. And the memory's capacity is only 512 bytes. It's mounted directly on the board and takes up about a third of the space on it.

Standard hybrid microcircuit cards plug into the rest of the board; they can process data four bits at a time at a 3-microsecond rate. The complete unit, excluding input/output controls and a power supply, is only 3 by 15 by 15 inches and weighs 24 pounds.

Solid state color tv in works at Zenith

Zenith is reportedly working feverishly to produce its first all-solid state color television set. Motorola started the trend two years ago, and RCA began shipping its first solid state color sets to dealers earlier this month.

In a related move, an industry source says Zenith will introduce a chassis with removable printed-circuit boards similar to Motorola's scheme [Electronics, July 10, 1967, p. 45]. The company has traditionally used the costlier hand-wired chassis. Zenith will use more printed circuits—all socket-mounted for easy replacement—than any of its competitors.

Picturephone ready for trials next year

It now appears that AT&T may be far enough along in its development of the Picturephone to introduce it commercially on a limited basis some time next year. Company sources indicate that the service will cost $100 a month.

However, before going to the marketplace, the Bell System in February will conduct trials of the device—a combination telephone and two-way television viewing system—between the New York and Pittsburgh offices of Westinghouse Electric. Some 40 sets will be used in the test.

Laser helps driver in Ford experiment

Practical applications are still a long way off, but for the past year Ford engineers have been experimenting with a laser range finder that controls a car's throttle and braking systems. A driver is still required for steering. The system, mounted in a Thunderbird, will be demonstrated next month. It's composed of a gallium arsenide diode laser that emits a 60-milliwatt continuous-wave signal, a conventional infrared detector, and a computer to interpret the return signal, calculating range and range rate.

Air Force to test relaxed procedure for documentation

The Air Force Systems Command has decided to give its streamlined systems engineering management procedure [Electronics, Sept. 16, p. 153] a try, even though it's still classified as a test document. The new format, devised after complaints that the Air Force's 375-5 procedure was restrictive and generated too much paperwork, will first be applied in the contract definition stage of the FX tactical fighter program. Projects being considered for the new approach include the AX attack aircraft and the Light Intertheater Transport, and there's an outside chance that it might be used for the Airborne Warning and Control System.

Testing of the new format, which will be the basis for an eventual Defense Department standard, has been held up by Pentagon, Army, and Navy reviews. This is why the new procedure won't be used in the initial source selection of the FX program. The tri-service plan in effect during contract definition, however, will be "basically the same document as the relaxed one," says a command spokesman, "but the Defense Department, the Army, and the Navy may change or clarify it."
MOS ANALOG FUNCTION GENERATOR

Complex analog functions, like that in Figure 1, can be digitally generated as fast as 125,000 analog levels a second. The generator fits on a small printed-circuit board, because the function is stored as binary bits in an MOS read-only memory and is read out through an integrated-circuit digital-to-analog converter. In the past, slow and bulky electromechanical equipments, such as photoelectric mask scanners and machined-cam followers, were used to generate signals as unusual as these.

The initial application of the MOS generator is drawing special test patterns on a CRT screen. An operator can compare the generated function with the signal produced by systems or transducers excited by programmed test stimuli. This substitutes a quick go-no-go curve-matching test for a laborious measuring and plotting procedure. It takes little imagination to see many non-display applications. Coders and decoders for secure communications, analog computers and simulators, and automatic control of processes are a few probabilities.

The memory circuits are 256-bit MM520's, which are frequently used as character generators (Figure 2). Programmed metallization masks are used to store code words during chip manufacture. Connections are made or not made at each storage node in the chip, depending on whether the code calls for a binary "1" or "0" at that node.

Figure 3 represents the operating model that produced the scope photos in Figure 1. Coding of the analog levels is somewhat like pulse-code modulation. The number, N, of bits in each binary-coded word determines the waveform resolution:

\[
\% \text{ Resolution at full scale} = 100/2^N
\]

For the model, 6-1/4 percent was ample, so each word is four bits long and each MM520 thus stores 64 distinct, quantized levels.

The bits are read out serially when a logic "1" signal triggers the start input of the first MM520. The end-of-sequence pulse from the first MM520 triggers the next, and so on through the string. Flip-flops A and B (MM583 JK binaries) generate the trigger pulse and also divide the clock by four, so that the MM508 serial-in/parallel-out register will separate the serial bit stream into the four-bit code words.

Four more MM583 flip-flops and four MM580 dual NOR gates operate as buffered registers to hold the four bits of each word and drive the A/D converter. The converter is a four-run resistor ladder and an MM551 multiplexer used as a series switch. Errors in the analog output are detected and nulled in the ladder via the feedback loop of the LM201 operational amplifier. Full-scale voltage adjustment is provided in the feedback loop by potentiometer R1. All analog levels appearing at the output are equally spaced in time, since the system is synchronous.
If greater resolution than 6-1/4 percent is desired, the words can be made longer, of course, by merely extending the clock divider and converter logic circuits. One operational amplifier will still suffice. In fact, this portion of the system can easily be time-shared by several function generators if a programmed selector switch is added. Or the operator can change functions by manual switching or plug-in replacement of the MM520 strings.

Some applications require a periodic function—for example, a complex sine wave. The auxiliary circuit in Figure 4 makes it unnecessary to store both positive and negative halves of the function. In the working model, the ripple counter produces a sign-reversal pulse at 64-word intervals. Delivered to the MM550 analog switch, the pulse periodically connects the function-generator output to the positive or negative side of the operational amplifier. Here again, the number of circuits used can easily be changed to fit the function-generation requirement.

Stored code words can also be used to divide an oscilloscope's sweep into regular angular increments, or to produce other special traces that may be required in analysis work. Since the words are digital, they can also be used to compute automatically the sine, tangent or other mathematical functions of the analog signals that are displayed.

Complete data sheets and additional applications information on all the MOS devices are available upon request.

FIGURE 4. Analog Inverter Reverses Polarity of Periodic Functions.
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The following high purity alloys and gages are produced in commercial quantities at Republic:

<table>
<thead>
<tr>
<th>Alloy</th>
<th>Gage in Inches</th>
</tr>
</thead>
<tbody>
<tr>
<td>1180</td>
<td>.00040 — .0050</td>
</tr>
<tr>
<td>1188</td>
<td>.00065 — .0050</td>
</tr>
<tr>
<td>1199</td>
<td>.0010 — .0050</td>
</tr>
<tr>
<td>0191</td>
<td>.00065 — .0050</td>
</tr>
</tbody>
</table>

Widths — Widths are available in some alloys from 1/4".

FOIL FOR COIL WINDING
Republic supplies both precision slit* and edge contoured* aluminum strip conductor for coil winding.

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Electronics | November 25, 1968

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Other applications might include: decoupling in “B” circuitry; noise suppression; RF isolation in filament circuits; use in combination with capacitors to form “L” networks.

**FIGURE 1**

Sample quantities of Ceramag* beads and beads with leads are available without charge upon request. Send your requirements to Stackpole Carbon Company, Electronic Components Division, St. Marys, Pennsylvania 15857. Phone: 814-781-8521. TWX: 510-693-4511.

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2. Digital to Analog Conversion
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3. One of the World's Fanciest Op-Amps
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Companies

Making it

Stanford R. Ovshinsky, a 46-year-old inventor who proudly tells visitors that he never made it beyond high school, called a press conference earlier this month to announce that the prestigious Physical Review Letters was about to publish his technical paper "Reversible Electrical Switching Phenomena in Disordered Structures"—a description of an a-c switch made of a homogenous film containing no rectifying junctions.

Generally, announcements of such a narrowly technical nature are received with something less than enthusiasm by the public press. But this conference, held in Ovshinsky's small office in Troy, Mich., was attended by reporters from such national newspapers as the New York Times and the Wall Street Journal. The Times subsequently front-paged the story under the headline, "Glassy Electronic Device May Surpass Transistor."

Overnight fame. The impact of this publicity was immediate: the price of stock in Ovshinsky's small research company, Energy Conversion Devices, tripled, and Ovshinsky's phone began to ring incessantly. Stockbrokers, investors, and executives of electronics companies deluged his office with questions, requests for licenses, and even offers to put money into the firm.

The reaction was understandable. The newspapers, apparently basing their reports strictly on the information they received at the news conference, heralded Ovshinsky's device as the eventual key to such long-sought developments as the complex, low-cost desk-top computer, the flat, tubeless television receiver, and the missile-guidance system that's impervious to high radiation.

What's new? What the newspapers didn't note was that Ovshinsky's invention (he calls it an Ovonic device) was reported years ago by the technical press [Electronics, Sept. 19, 1966, p. 191, for instance]. In fact, Ovshinsky long ago licensed the device to several U.S. firms—ITT among them—and to Danfoss AS of Denmark and L.M. Ericsson of Sweden. And sample quantities of the Ovonic device have been sold to research firms for tests over the past few years.

Also, initial press reports didn't point out that Ovshinsky isn't the only claimant to the technology. Bell Telephone Laboratories reported the development of a memory device made of an elemental glass in 1962, and received a patent on the material on March 15, 1966. Ovshinsky was granted a patent on his device on Sept. 6, 1966.

Bell says it doesn't want to be drawn into a controversy at this point, but it does add: "We are of the opinion that nothing new has been disclosed in [Ovshinsky's] paper."

Mixed reviews. However, any dispute on this score may be academic. Despite the years of research that have gone into Ovonic devices, apparently no one has been able to go beyond building more than workable laboratory models. ITT, for example, is understood to have made a few Ovonic devices that worked in a system. But the company now appears cool to the development and hints that no work is being done on it. Many other electronics firms have indicated similar disenchantedment.

In fact, some semiconductor industry executives questioned about Ovshinsky's device deride it as "a crackpot scheme" or "a fraud." Ovshinsky, an ebullient man, brushes off such comments. He confesses that he's delighted, but hardly awed, by the sudden publicity.

And certainly not everyone in the electronics field is ready to write off his work. A random sampling of researchers indicates that the scientific community tends to take a wait-and-see position.

Phenomenon. Just what are the properties claimed for the glassy substances in Ovonic devices? The materials—mixtures of tellurium or arsenic or both with other elements in the III, IV, and VI groups—have a resistance in the megohm region as long as the voltage across them is below some level, which can be selected by adjusting the mix. When the voltage reaches this threshold, the materials switch to the conducting state. Some of them stay in this low-resistance state even after the voltage is removed, while others switch back when the
current falls below some minimum. No one questions the existence of this switching effect, but many doubt that it can be applied in a mass-produced device.

Until recently, Energy Conversion Devices made only discrete switches, but it's now concentrating on developing a thin-film process. Ovshinsky says that he can put 2,500 switches on a 1-inch-square substrate and that his firm can crank out 60 of the substrates—with 150,000 switches—in one batch.

But the process isn't completely refined, and all the thin-film devices are fed back into the company's in-house testing program. How well this program is going is a moot point because Ovshinsky won't supply information on the repeatability and reliability of his thin-film devices.

The company says the thin-film switches will never be sold off the shelf but will be used in systems designed by Energy Conversion Devices engineers. The company is unwilling to predict when the first commercial system will appear.

Until these systems are ready, the company will continue to sell sample quantities of the discrete switch to selected companies and to seek contract work. Energy Conversion Devices now has a few contracts, one of them with the Avionics Laboratory at Wright-Patterson Air Force Base.

Industrial electronics

A night to forget

As if the drama of election night wasn't enough, there was a subplot that might have been entitled "Man versus Machine," with IBM being miscast in the role of the villain.

The News Election Service (NES), set up by the two national wire services and three major television networks to ensure fast, accurate tallies, began to lose its poise at the height of the vote counting. Not only did the system's central computers—two IBM 360/40's—start to spew out some obviously inflated vote totals around 10 p.m., but at one point they pegged the percentage of ballots cast in one state at 177%.

Needling. So while IBM representatives twitched and tv commentators waxed sarcastic about the computer industry, NES workers rushed about frantically trying to find out what was going wrong. They finally agreed to take the central machine off line and rely on their backup system of seven regional 360/30 computers—slowing the tallying process somewhat.

But the problem, it was later discovered, was not in the hardware at all, Huntley and Brinkley to the contrary. It was, according to NES director J. Richard Eimers, "solely due to software. I have no complaint with the hardware."

Eimers also points out that the regional centers were able to carry the load efficiently from about 2 a.m. Wednesday until midnight, when the primary system was put back on line.

NES was set up to receive precinct results at its regional centers from 118,000 reporters via telephone, and tallies from the 50,000 precincts that use automatic vote-counting equipment via Data-Phone. The raw data was put into a format at the regional centers and fed simultaneously to the two primary computers at NES headquarters in New York and the seven backup machines. Both the central and regional computers were to tally the votes, but only the central system was to transmit the tabulated results to the service's five members and 11 subscribers.

Snowballing. But things didn't quite work out that way. Actually, the errors involved only 10 or so counties, but in some cases they were gross enough errors to possibly affect state results and therefore Electoral College totals.

The question that puzzles many is why the backup system worked when the central system didn't, especially since both used programs supplied by the same firm, Programming Methods Inc. of New York. "The answer," explains a PMI spokesman, "is that the program for the backup system had been thoroughly debugged and tested in the primary contests."

Also, each backup computer was responsible only for the votes in its region. In the case of the central system, one computer (with the other acting as a fail safe) handled data from all seven regions. The program used at headquarters was infinitely more complex and, more important, it was untested.

Displays

See-through view

Designers of displays—whether for computers or wall-size projections—have concentrated on two basic technologies: vacuum tubes, such as cathode-ray and Nixie tubes, and solid state devices, such as light-emitting diodes and electro-luminescent panels. Researchers at the Sandia Laboratories, however, have taken a different view: the see-through approach.

Instead of having the material light up itself, they've developed a ferroelectric ceramic that takes white light and, with electronic switching, blocks out all but the wavelength desired. The result: a panel, illuminated by ordinary light from the rear, can produce a full-color display as big and as bright as you please.

Crucial to the Sandia approach is the ferroelectric ceramic lead zirconate titanate, discovered only a dozen or so years ago. Sandia's scientists found that the material has two very interesting properties. It exhibits hysteresis—that is, having been polarized with a voltage pulse, it retains the polarized state without being continuously addressed. And it can be selectively polarized: its degree of polarization depends on the amplitude of the applied voltage pulse. The material's birefringence, together with the selective polarization, provides the varying colors.

Making a rainbow. The Sandia scientists—Cecil E. Land and Donald G. Schueler—found that they could pack the ceramic cells tightly
enough to produce a picture with good resolution. A panel that's now being made contains 100 cells in an area 130 by 65 mils. The package is 2 mils thick.

A voltage applied to the ceramic rearranges dipoles throughout the material. So, when a white, polarized beam enters the birefringent material, the wavelengths are split apart and each is shifted in polarity by a different amount. Out the other end, then, appears a rainbow, with each color having its own plane of polarity.

To apply this effect, the Sandia scientists put together a surprisingly simple package. The ceramic color cell is sandwiched between two sheets of polarizing material, and electrodes, attached to both sides of the cell, are connected to a pulse generator. The only other item needed is the external light source.

**Singing the blues.** In operation, then, a white, unpolarized beam hits the ceramic and gets broken into its component wavelengths. After that the beam hits the final polarizer, and only the component that's polarized in the same direction gets through—producing one dot in the display. To switch the color, the operator need only send a new voltage pulse to the ceramic; such a switch takes but 100 microseconds.

The design does have weak spots. For one, the blues and blacks are very weak. To help step up the blues, the developers are considering using a bright blue light as the source. The design also suffers from some crosstalk problems, but the Sandia researchers believe that by improving the fabricating techniques they can solve them.

Although displays may be the development's broadest application, another possibility is an erasable color slide.

Several private firms already have the development under review for commercial applications and have applied for a license, which Sandia—an Atomic Energy Commission prime contractor—provides free.

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**Advanced technology**

**New way to look at it**

As current is pulsed across the junction of a semiconductor, electrons take on energy, jump out of valence positions on one atom, and move to the valence ring of another. When an electron drops out of its excited "carrier" state and recombines with an atom, it emits a small amount of energy called recombination radiation. If detected and measured, recombination radiation could be a useful tool for engineers, since its intensity is proportional to current density. Even if the detection scheme yielded only a qualitative yes or no indication, it would still be useful in spotting overloaded components and nonoperating junctions.

But recombination radiation is only about $10^8$ as intense as the infrared emission caused by thermal effects in the chip. Virtually all the energy of recombination is soaked up in phonon generation rather than more easily detected photon radiation.

**Serious effort.** Thus, while discussions of recombination radiation are nearly 10 years old, nobody seems to have made a serious effort to detect it until NASA's Electronic Research Center in Cambridge, Mass., funded the work of Riccardo Vanzetti, former manager of the Raytheon infrared techniques and systems department, Wayland, Mass., (see page 14).

"Theoreticians had decided that recombination radiation was too weak to detect," says Vanzetti. "I proposed study after study on recombination, and each proposal was turned down—once or twice because those in authority were trying to save me from making a fool of myself, I think."

Vanzetti finally got the money he needed about a year ago under a contract entitled "Transient infrared radiation in semiconductors." "We couldn't have called it 'recombination radiation' and still gotten funds," he says. "All the experts 'knew' it was undetectable."

Vanzetti himself had a few anx-
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Electronics Review

ious months until he first detected the weak emissions last February. "We picked a solid state diode and pushed it way outside its rated current densities. Finally, it emitted enough radiation for us to spot and show on a scope," he says.

The detector has been made more sensitive since then, allowing him to study integrated circuits operating within and below their ratings. Vanzetti's detector is a cryogenically cooled avalanche photodiode adapted from laser communications experiments. The photodiode is most sensitive to wavelengths of about 1.06 micron, putting it in the middle of the band of interest; silicon emits recombination radiation at about 1.1 to 1.2 microns, while germanium emits at 1.8.

Wont detail. Even with a sensitive detector, Vanzetti found it necessary to add signal-processing electronics and a specialized optical pickup. The processor—a so-called waveform extractor—is a digital signal-averaging device; further details are under wraps as Vanzetti applies for a patent on it. The optical pickup is straightforward, however, consisting of a single optical fiber.

Trying large fiber optic bundles, Vanzetti found them too large to allow him to view IC's in the detail he wanted. With the single fiber pickup, though, he can view areas as small as a part of a junction.

"The fiber also acts as an optical bandpass filter," he adds, "discriminating against unwanted wavelengths which would otherwise add to noise and make the signal we want to view hard to spot."

By improving the pickup and signal-processing electronics, Vanzetti has been able to boost the signal-to-noise ratio of the detector to about 20 times the level of early experiments. "Where formerly the pulse was barely discernible, now it rises cleanly above the noise shown on the scope trace," he says.

Since detecting recombination radiation, Vanzetti has left Raytheon to form his own firm, Vanzetti Infrared & Computer Systems in Dedham, Mass., and his detection scheme is going to be his stock in trade. He says that it will "let engineers check how pulses flow through IC's. For the first time, designers will be able to detect crosstalk, proximity effects, pulse distortion—and study designs, not just through their input-output characteristics, but by looking within the circuit."

Spotting failures. "Quality assurance engineers would not only be able to spot failure, but also to determine exactly what transistor or diode is failing. Buyers could check vendor process control by noting chip-to-chip variations in junction performance within lots of IC's—vendors with small variations would have good control and vice versa," he says.

Vanzetti's detection scheme may be important to development of dependable large-scale integrated circuits, too. He feels that "the output of an LSI device doesn't have very much information content relative to the number of active elements in the chip; one waveform looks much like another. But with recombination detection, an engineer could look at two devices with identical outputs and spot differences in the performance of individual components, possibly finding potential failure points before making final design decisions."

Vanzetti plans to make the detector available as a commercial product, perhaps by mid-1969. But for the immediate future, he notes that there is still work to be done in relating oscilloscope displays of detected radiation to specific failure or operating modes. Vanzetti feels that the technique needs a body of statistics to support its worth.

"Without such figures, engineers might not take the idea seriously," he says with a grin. "After all, recombination radiation is 'known' to be undetectable."

Avionics

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Texas Instruments Incorporated

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been funded by the Avionics Laboratory at Wright-Patterson Air Force Base to do just that. Both Litton Industries and Bunker-Ramo are making their developmental models predominantly with metal oxide semiconductor technology, with Litton using unpackaged large-scale integrated wafers [Electronics, June 24, p. 47] and Bunker-Ramo medium-scale integration.

Litton uses a form of discretionary wiring outside the wafer to connect good devices on wafers with as many as 20,000 MOS transistors. After the wafers are probed, a functional unit that fails is programmed out of the loop.

Albert Goldstein, manager of the data equipment department in Bunker-Ramo's Defense Systems division, thinks the company has a better idea, using what he calls MSI packaged chips in a "bit-slice" form of organization.

Featherweight. The associated bits of five different registers—plus the associated logic or gating to transfer signals between these register bits—are all put on one chip.

"This is a functional approach to component design that reduces backplane wiring or interconnections between components," Goldstein says.

The development model will prove out the four kinds of MOS chips designed by Bunker-Ramo and built by General Instrument. The initial computer will weigh about 4½ pounds and take up 145 cubic inches. Goldstein says, however, that a production version using leadless ceramic multichip packages (instead of the one-chip, 44-lead metal flatpacks in the development model) will reduce the weight to 2.15 pounds and the size to 43 cubic inches.

A production version of the computer would consume about 22 watts, Goldstein says, and have a generalized input/output system and a memory with 2,000 words of 16 bits each. The Air Force has asked Burroughs to develop the electrically alterable nondestructive read-out memory, which contains a planar film. It will have 1-microsecond read and write cycles.

The four basic chips Bunker-Ramo engineers have designed are...
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processor modules, two basic input/output modules, and a memory module.

The Bunker-Ramo development model will have four double-sided circuit-board modules; a programmable data processor module with 54 IC flatpacks plus 25 14-lead bipolar IC's to interface with the outside world; hybrid thin-film clock oscillators and drivers; an input/output module, and a memory interface module to be used in testing with a memory other than the Burroughs planar-film type being developed.

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**Communications**

**A single voice**

The Presidential Task Force on Telecommunications is planning to suggest that Comsat serve as the nucleus of a new company that would take over the international transmission facilities of all existing U.S. carriers. In a nearly final working paper, the task force says the monopoly would end what it calls the inefficiencies of competition between satellites and cables.

Comsat has about $160 million in cash reserves; it's estimated that the proposed new company would have assets of $500 million. International carriers, in addition to Comsat, include AT&T, ITT World Communications, RCA Global Communications, and Western Union International, which was separated from the domestic Western Union in 1962.

**Hot potato.** The recommendation seems certain to be the most controversial in the task force report, which is due to be released in late November after 16 months of work. The private carriers will probably complain bitterly about the plan.

The recommendations are so sweeping that even the Administration may treat the report like a hot potato. And chances are that the new Republican Administration will be even less eager to ask Congress to enact all the recommendations. But the problems that led the task force to the study in the
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Electronics Review

first place are so acute that they'll have to be faced somehow.

The task force feels that economy and coordination are impossible in the present situation, because the private carriers are economically tied to cables and the FCC is caught in the middle between the two technologies as it tries to work out formulas for parceling out the business.

The task force is critical of the FCC. The panel thinks the agency erred in letting cable carriers build new facilities and protecting them from Comsat competition by directing that cables and satellites be used equally.

The plan for granting Comsat a new charter may conflict with another section of the task force report that calls for granting Comsat authority to build and operate a "pilot" domestic satellite system. In the section on international carriers the task force says that no company with an interest in domestic communications should have a part in the new entity. This conflict could mean the task force has concluded that Comsat should not be given more than interim responsibilities for domestic service.

The domestic restriction also means, of course, that the carriers would have to sell their holdings in Comsat, which total 41%.

Old idea. The report doesn't work out wording for the legislation, but does suggest that the new entity be closely monitored by the FCC, make procurements competitive, not be connected in any way with the manufacture of communications equipment, and have no terminal-connection functions. The new entity could deal directly with users needing no more than raw bandwidth.

The single entity, the task force believes, would provide a united front for U.S. interests overseas, be easier to regulate, help the Government in its foreign dealings, and ultimately cut transmission rates.

The suggestion isn't new—several groups, including Congressional committees, have urged such an entity—but the task force is the first to suggest even the basic mechanics for creating one and to propose Comsat as its nucleus.
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THE 5245M COUNTER. The respected "uncle," this counter is nearly identical to the 5245L, except it has the most stable and spectrally pure time-base oscillator ever built into an off-the-shelf counter. Aging rate is 5 x 10^-10/day and short term stability is 5 x 10^-11 rms (1 second averaging). With rapid warm-up, this crystal oscillator is an excellent secondary frequency standard, whose S/N ratio is typically >87 db. Price: $3100.

THE M54-5245L COUNTER. The family "hero"—the military ruggedized version of the 5245L. Meets MIL STD-108D section on moisture-proof enclosures, and MIL specs for shock, vibration, humidity, temperature and electromagnetic compatibility. Still basically the 5245L. Price: $2850.

THE 5246L COUNTER. A stripped-down economy version of the 5245L, this "cousin" has a 6-digit readout and a time-base aging rate of <2 parts in 10^7/month. Options available are 8-digit readout, BCD output, and 5245L time base. It also uses all the 5245L plug-ins. Price: $1800.

THE 5247M COUNTER. This "cousin" is for rapid but accurate "hands-off" measurement of an extremely wide range of signals. It measures frequency only, directly to 135 MHz (to 18 GHz with a plug-in frequency extender), and accepts any input voltage between 100 mV and 10 V without trigger level adjustment. It's similar to the 5249M in ultra-stable, rapid warm-up characteristics. Price: $3150.

THE 5244L COUNTER. This member of the family is the "basic frame" counter. It doesn't accept plug-ins, but sports the frequency, ratio and period measurement versatility of the 5245L. Frequency range is to 50 MHz, with standard 7-digit readout and BCD output. Time-base aging rate is <2 parts in 10^7/month. Price: $1900.

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Washington Newsletter

November 25, 1968

NASA okays ATS-E tests of L band... The space agency has finally given a go-ahead for work on hardware for the first tests of aircraft-to-ground communications via satellite relay at 1,540 to 1,660 megahertz. After much deliberation, NASA decided to include an L-band transponder on its fifth Applications Technology Satellite, an addition proposed by the FAA. But the late change in equipment will delay the ATS-E launch from May to August [Electronics, Sept. 2, p. 54]. There isn't time enough now to design from scratch an L-band transponder for the spacecraft, so the ATS project office will have Hughes—the satellite builder—convert existing C-band equipment. The transponder won't be the perfect one for the job, concedes Don Fordyce, ATS project manager, but it will be the best possible with the time and money available. NASA is now developing specifications for the transponder and Hughes should have it ready to go by June.

... and FAA plans to make the most of its opportunity The FAA—prime mover in getting NASA to fly the L-band transponder—plans to conduct as many experiments with the equipment as its funds will allow. The FAA is now negotiating with manufacturers to line up aircraft and ground equipment for voice communications tests, and the first contracts covering this phase of L-band utilization should be awarded in about a month. Other experiments the agency is considering include air-to-ground ranging trials and the feeding of the ranging data to experimental air traffic control displays. All of this would be expensive, but an FAA communications expert says: "We are committed to the voice experiments and I think that R&D funds will be made available for the rest of the proposed experiments. We've been waiting a long time for a crack at L band, and we hope to take full advantage now that we have it."

Future ATS craft to get L-band gear Though a month ago it appeared that an L-band satellite transponder might be a long way off, it now looks as if there'll be several of them soon. In addition to the ATS-E, the follow-on ATS-F and probably the ATS-G craft will carry L-band gear to support a new program in which the Goddard Space Flight Center will try to demonstrate the feasibility of L-band communications, position locating, and ranging. Place—for position location and communications experiment—will initially employ the ATS-E L-band equipment in conjunction with the Navy's Omega navigation system. When ATS-F is launched, the Omega portion will be dropped and a sophisticated dual-satellite ranging system put into operation. Goddard already has been told unofficially that an L-band transponder will be approved for the ATS-F.

Schriever seems likely NASA head The man most mentioned in Washington as Richard Nixon's choice to head NASA is retired Gen. Bernard Schriever, former head of the Air Force Systems Command. Schriever campaigned for Nixon and wrote some speeches on space for him. His appointment would probably lead to moves to combine military and civilian space activities. Schriever currently heads his own consulting firm [Electronics, Aug. 19, p. 59].
NIH fears outlay may be cut by Nixon

The National Institutes of Health is slated for a healthy increase in biomedical research spending this year, but its officials are increasingly uneasy over the possibility that the new Administration may cut back these funds. In fact, one NIH official flatly predicts that the outlay will be reduced after Nixon takes over.

The Department of Health, Education, and Welfare has approved fiscal 1969 expenditures of $30 million for the research, up from $20 million in fiscal 1968. The money would cover work on medical applications for instrumentation, lasers, and computers, among other things.

Air Force negotiates computer contract

The Air Force is currently negotiating with several companies for the development of an advanced airborne computer for its FX fighter and the AX attack planes. The Air Force won’t say with whom it’s negotiating, but four of the several companies believed to be in the running for the important award are Burroughs, IBM, Raytheon, and TI.

If selected, Burroughs would be building its first airborne computer. The company is understood to be designing a machine with complex integrated circuits containing between 100 and 200 gates.

Profit inquiry likely on defense gear that’s below specs

The General Accounting Office may look into profits made by contractors on military electronic equipment that doesn’t meet performance specifications. This is one of the tasks that Sen. William Proxmire (D., Wis.) will probably include in his proposal for an investigation of defense profits.

Proxmire is particularly angry over a Budget Bureau study reporting that “performance has little correlation with profit” in the case of military electronics gear. There is a “high incidence of delivered electronic systems with degraded performance,” but contractors aren’t penalized because of “the current special partnership that exists between Government and the aerospace industry,” the report said.

Although the Pentagon won’t openly oppose Proxmire’s proposal, it feels that its own studies of profits from noncompetitive and negotiated contracts are sufficient.

Army readies RFP’s on missile controller

The Army Missile Command expects to select a contractor this spring to develop a prototype missile fire-control system to succeed the Hughes-built AN/TSQ-51. Designed for the Nike-Hercules system, the TSQ-51 Missile Mentor has been operational for only two years. The new TSQ-73 will be designed to handle the Hawk, SAM-D, and Sentinel missile systems in addition to the Nike-Hercules.

Requests for bids on the R&D contract will soon be issued to selected companies, with answers expected within three months.

The TSQ-73 will feature “as great a miniaturization as we can get,” says one military source. “But it will be MSI,” he adds, “since LSI isn’t proven yet.” The computers will be built of throwaway modules and will have a self-testing capability.

Addendum

A contractor will be named shortly to build a prototype airborne solid state teletypewriter with a cathode-ray-tube display. The Air Force is now evaluating bids from 18 companies; the prototype will be due a year after work begins on the contract. The service wants a compact terminal with a variable speed (75 to 2,400 bits per second).
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Electronics | November 25, 1968
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The growing complexity of integrated circuits spotlights a serious drawback of semiconductor devices: the unreliability of wire bonds. And the advent of medium- and large-scale integration has increased the need to automate the bonding process. As an answer to both the problem and the need, some manufacturers are going with flip chips, some with beam leads. Still others are investigating both methods, and one maker, Motorola, has reached the production line with a third technique—the spider bonding shown on the cover. This survey, the first article in a two-part series, covers the cost and reliability aspects of competing techniques.

Circulators and isolators are solving some of the worst isolation problems that have frustrated designers of vhf through microwave circuits and systems. Although the solutions still involve tradeoffs, these ferrite devices, among other tasks, isolate a transistor oscillator or amplifier from a varying-load impedance with little loss in the usable output.

To put an engineer's schematic in one end of an automated production line and get a completely assembled printed-circuit card at the other is the goal of a manufacturing system being set up by Kearfott Products. A few human operators are still needed, but the combination of new machines and tape and computer control brings completely automatic circuit manufacturing a giant step closer.

Detailed design information on the Nova, the third generation's first small computer, will cover its architecture, its multiple accumulators, and its unusual read-only memory.
In search of a lasting bond

Beam leads and flip chips have their advocates, but many firms continue to weigh the cost and reliability advantages of the two techniques; meanwhile, Motorola has put forward a third: spider bonding

By Lawrence Curran
Los Angeles bureau manager

Ask any engineer concerned with semiconductor reliability what his biggest headache is, and the odds are he'll tell you it's faulty wire bonds. The wires pull away from contact pads on the dice or they separate from package lead frames under stress.

The logical way to solve the problem is to eliminate wire connections altogether. In doing so, the semiconductor manufacturer can not only improve device reliability but reap some labor savings by eliminating the 28 manual bonds required in fabricating the typical 14-lead integrated circuit. And as the industry moves into the realm of medium- and large-scale integration, the need to automate bonding becomes more pressing.

Several ways to eliminate both wires and manual connecting processes have emerged in the past few years—flip chips, beam leads, and spider bonding. Many of the larger semiconductor manufacturers and users are examining all these possibilities before they commit themselves. Others have come out solidly for either flip chips or beam leads, and one maker is offering spider-bonded circuits.

There does appear to be a trend at semiconductor houses toward flip chips because they're easier to make than beam-lead devices. But there are also indications that beam leads will be the way to go to achieve the highly reliable devices required by the military services.

In the flip-chip method, which has been in use

The hard way. Sprague Electric chose a small-geometry device for its entry into the beam-lead field, a dual four-input NAND gate.
for about six years, metal bumps or balls are applied to the contact pads on the die in place of wires; the bumps are bonded with the die face down in a one-shot or reflow solder operation.

The International Business Machines Corp. is applying a modified flip-chip technique called solid logic technology (SLT) to its 360 computer line. Here, one or two transistors are bonded face down to a hybrid thick-film substrate on which stencil-screened land patterns and passive components have been deposited. Bonds are made to solder-covered copper balls, which contact the emitter, base, and collector. Solder on the balls flows when the chips are heated, forming the bond. IBM passivates its active devices with phosphorous silicate and uses a can that isn't hermetically sealed. The can's function is simply to protect the devices against mechanical damage in handling.

IBM officials say the company is turning out hundreds of thousands of SLT circuits a day, plus like amounts of slightly more complicated devices called solid logic dense (SLD) in a fully automated setup. The SLT circuits are said to have a bond failure rate of 0.00004% per 1,000 hours and an electrical failure rate of 0.0002% per 1,000 hours.

The firm has also announced a new process that appears intended for use in bonding IC's containing many elements to substrates [Electronics, Oct. 28, p. 50]. Called "controlled collapse," this technique dispenses with the copper balls employed in SLT to keep the chip above the substrate so it doesn't short out. In controlled collapse, molten solder holds the chip off the substrate. A large portion of the lands is coated with glass to protect it from the effect of bonding heat. Heated solder can thus flow only over the tiny uncovered portion of the lands, and there isn't enough of this solder to short the circuit.

The General Electric Co. has developed a wireless bonding method called semiconductor on thermoplastic on dielectric (STD) [Electronics, Jan. 8, p. 45], but the Commerce Department has clamped a lid of secrecy on the project at the behest of the Pentagon. However, though the Government now deems the technique vital to the nation's security, some general details were published before the program was put under wraps.

It's known that under the STD process, the IC is nestled among copper projections or mesas on a substrate. The circuit is embedded in a clear, heat-resistance plastic that's flush with the mesa tops, and it's linked to the outside world by metal interconnection paths deposited on the plastic.

Versatility appears to be one big advantage of STD. The technique can be applied to discrete devices or up through large-scale integrated circuits, and can be used with thick- or thin-film compo-
Mosaic. A control logic circuit with 47 logic gates and seven flip-flops is among the most complex beam-lead chips yet built. The beams on this Bell Labs circuit are 2 mils wide and 7 mils long.

Over the edge. A 40-gate, beam-leded TTL chip built by the Raytheon Missile Systems division has interconnection lines in the center channels for the various circuits along each side.

ments or any combination of them. Besides these benefits, STD offers a way around the alignment difficulties of the flip-chip approach. Also, because the chip is face up in a clear plastic, it can be visually inspected.

Delicate operation

In the beam-lead method, which was pioneered by the Bell Telephone Laboratories, a gold metalization system not only interconnects individual components of an IC but provides a way to join the circuit to the outside world. The gold beam lead is relatively thick (12 microns) and extends beyond the boundaries of the silicon circuit, like a cantilevered beam, to contact the circuit-board pads.

Exposed terminal points are interconnected by electroplated gold leads placed on top of successive layers of platinum silicide, titanium, and platinum. The platinum silicide offers a good low-resistance ohmic contact to the silicon at the terminals, titanium bonds the platinum layer that goes on top of it to the nitride in the contacts' overlay portion, and the platinum protects the underlying layers from gold migration.

Separating the individual devices is a ticklish proposition since ordinary dicing obviously would damage the beam leads. At Bell Labs, the wafer is coated with wax and mounted, with the beam leads down, on a flat sapphire disk about 0.09 centimeter thick. The back of the wafer is lapped to a thickness of about 0.005 cm, and a coat of emulsion is applied to the wafer. The connection grid pattern required to separate the chips is defined by a mask that's aligned with the aid of infrared light, and
New ballgame

IBM was the first to mass produce flip chips. In the solid logic technology process it uses to form modules (upper right) for the 360 computers, the basic substrate has screened resistors and conductors with pads that contact the three transistor terminals. Each transistor has three solder-coated copper balls. When heated and placed on the pads, these bond the transistor to the substrate, make the electrical contact, and keep the device from collapsing onto the substrate and shorting the circuit.

In a newer method, shown at the lower right, the copper balls are replaced by solder balls, and another step is added. A nonsolderable glass deposited over a small part of the lands near the chip end acts as a dam, blocking the flow of molten solder down the lands during the bonding process. The surface tension of the molten solder then holds the chip off the substrate until the solder hardens. This new "controlled collapse" technique offers the advantage of greater compliancy—a must when multielement chips are to be bonded to a substrate.

the wafer is then etched through with an acid solution. After separation, the individual devices remain fixed in their wafer orientation by the wax on the sapphire disk; they're tested automatically at this stage.

After testing, the devices are cemented to a wire mesh screen in the transfer fixture. The mounting disk is heated to remove the wax, and is then itself removed from the wafer.

Once the devices have been cleaned of any wax residue, the chips, wafer, and a resin-coated disc are clamped in a fixture and dipped in acetone to dissolve the cellulose nitrate used to hold the devices to the screen. The fixture is opened, leaving the chips clinging to the silicone resin, from which they can be easily removed by a vacuum pickup needle.

The Western Electric Co., manufacturing arm of the Bell System, claims that beam-lead devices they've made show a mechanical yield of better than 99%; electrical yield is expected to top 90%.

The spider bonding process recently unveiled by Motorola [Electronics, Sept. 16, p. 58] is an especially promising entry in the automation derby. The firm's Semiconductor Products division has gone to this technique for all its dual in-line, 14-lead plastic-packaged transistor-transistor logic circuits, and it can deliver these IC's today.

One machine at Motorola ultrasonically bonds semiconductor dice to spider-like leads stamped out of a continuous strip of metal, and another automatically wets the spider-bonded dice and leads to a header strip. Both operations are one-shot jobs, and the over-all process is said to be 20 times faster than manual wire bonding.

The availability of the company's spider-bonded IC's must be heartening to potential users, as flip-chip and beam-lead devices are still largely under developmental wraps.

Missile booster

Probably the greatest single boost beam-lead technology has gotten was the selection of beam-lead devices for the Army's Sentinel antiballistic missile system, Western Electric, prime contractor for Sentinel, has awarded initial contracts of $5 million each to Motorola's Semiconductor Products division, Texas Instruments, and RCA for these devices.

Also, the Raytheon Co.'s semiconductor operation, which showed air-isolated devices at last August's Wescon Show, has a contract to deliver both IC's and discrete transistors and diodes in beam-lead form to the North American Rockwell Corp.'s Autonetics division; it should be in production early next year [Electronics, April 29, p. 25]. Raytheon also has ambitious plans to apply beam leads to its entire commercial IC line.
Bumpy drive. Bipolar IC with solder bumps is a six-channel driver for a MOS-FET switch. This circuit, built by Siliconix, has only four channels bumped for input and output; the other two bumps are for supply voltage and ground.

William Hugle, president of Hugle Industries, Sunnyvale, Calif., reflects the thinking of many in the semiconductor industry when he lists the following advantages of beam leads:

- They are visible under ordinary optics at the connection points.
- Several methods of die attachment can be used, including spot welding, soldering, thermo-compression bonding, and ultrasonic bonding.
- The expanded size of the leads makes interconnection-path tolerances somewhat less critical than they are in flip chips or chip-and-wire devices.
- Beam leads are perhaps less susceptible to long-term stress bond ruptures than are flip-chip or chip-and-wire devices.

Others in the industry would add these features to the list:

- Little or no heat or pressure gets to the active semiconductor area in beam-lead bonding.
- The leads are wider than their chip-and-wire counterparts and therefore more rugged—though still delicate.
- Uniformity and repeatability of device characteristics permits preselection of devices—particularly discrete devices for microwave systems—after only a small sampling.
- Beam leads can be shaped to help control device inductance, something that can't be easily done with flip chips.
- The Bell Labs approach results in gold-to-gold bonds, which are more reliable than bonds involving dissimilar metals.

Generally, industry men reckon the disadvantages of beam leads thusly:

- To date, the leads and lead-chip interfaces are somewhat fragile.
- The gold and the added processing steps are costly.
- Beam-lead devices require a lot of silicon surface real estate because a large land area is needed to assure that the bonding tool is applied to the beam, not to the chip.
- Backside alignment is needed for the etch pattern to separate the chips from the wafer.
- There are few sources of supply.
- Beam leads have lower bond strengths than
do flip chips.

- The silicon chip used with beam leads is thin (2 to 5 mils against 10 mils or more for flip chips).

As for flip chips, Hugo points out the following advantageous features:

- Their processing is compatible with present IC production lines.
- They need less silicon surface than do beam leads.
- Once they are attached to the substrate, they're very rugged.
- Bonds are strong.

But here again there are drawbacks. Hugo notes the following ones:

- The bonds aren't visible after attachment except with infrared optics.
- Great precision is required in substrate conductor printing if maximum economy in chip size is to be realized.
- Flip chips aren't as easily repaired as beam leads. Hugo observes, however, that flip-chip makers are finding new ways to repair bad bonds.

Many semiconductor manufacturers are keeping their options open by developing both technologies in house. This includes most of the big boys—Fairchild, Motorola, TI, and the Signetics Corp.

Signetics is evaluating flip chips and beam leads from the point of view of reliability and cost trade-offs. David Kleitman, director of research and development at the Sunnyvale, Calif., subsidiary of the Corning Glass Works, says: "In any application where cost is important, flip-chipping has an advantage. Beam leads certainly double, and may triple, chip costs, and they will for some time to come."

On the other hand, Donald Winstead, Signetics' product marketing manager, states: "We still haven't proved the reliability of the flip-chip process. Beam leads seem more attractive to the marketing and management segments of the company because they offer a bond with more integrity."

Regarding Bell Labs' beam-lead processing method, Winstead says, "platinum-titanium-platinum-gold-gold metalization is a tough proposition. We have a major metals study going on now and we expect results in February, so we can look for beam-lead products by the middle of next year."

Motorola is backing all three horses in the race. Richard Abraham, director of both advanced IC programs and Motorola's Sentinel program, says: "The beam-lead approach is intended essentially to improve reliability; spider bonding was developed to cut bonding costs. The two techniques will be aimed at different markets and it will be a long time before they meet head-on. Our beam-lead effort is aimed at the high-reliability market. Spider-bonded IC's are currently packaged in plastic for the commercial-industrial market."

"I don't think there will be a major cost reduction realized by using beam leads," Abraham continues, "but we look for a major reliability improvement. We can see and inspect each bond produced by the beam-lead approach, and results are excellent. We can't find a centrifuge that will pull the bonds apart." The official adds that the most stringent centrifuge test spins the devices at 100,000 g's.

Secretive

The three firms funded by Western Electric to develop beam-lead devices for the Sentinel program aren't eager to talk about that effort. Motorola's Abraham is mum on the subject, as are officials at RCA. James Hubbard, manager of some of TI's advanced IC work, will say, however, that "there are some cost problems to be worked out with beam leads, but we see a need for them when we get into complex functions. They should complement discretionary wired medium-scale and large-scale integrated circuits. Although the bump approach might cut costs, the ultimate yield might dictate beam leads. These are questions we are trying to answer now with our studies of beam leads and flip chips."

Ross Schraeder, manager of IC package development at TI, has for two years headed the firm's
IC flip-chip development, an effort embracing both hermetically sealed and plastic dual in-line devices. TI appears to be closer to the market with the former, but Schraeder is more excited about the outlook for plastic-packaged flip chips. Several approaches are being examined, but Schraeder isn’t willing to give details. He simply says: “We feel this will be the big market and it’s the area in which we’re putting our biggest effort. We are studying various techniques in an attempt to select the most reliable and producible flip-chip package.”

Schraeder believes both flip chips and beam leads “have a place,” but feels flip chips will win out for high-volume orders. For one thing, he says, flip chips allow greater device density on a slice at lower cost. For another, they can be densely packed on a hybrid substrate because there are no leads overhanging the silicon perimeter.

Spider fancier

Fairchild’s eventual route has become more difficult to predict since the arrival at the company of a flock of ex-Motorola executives. One of them, Eugene Blanchette, Fairchild’s IC manager, was a big booster of spider bonding while at Motorola, maintaining that the degree of automation the process allows is imperative if semiconductor device costs were to be kept in line. He says Fairchild has lab notebooks that prove the firm was working on spider bonding as long ago as 1960, but he fails to explain why the process still hasn’t made it to the production stage.

One of Blanchette’s first actions upon moving to Fairchild was to stop production of the Fairpak, the flip-chip package that proved impervious to all cost-cutting attempts since the company introduced it nearly two years ago.

Blanchette had never been enchanted by the Fairpak; shortly after arriving at Fairchild he noted that “the metalized ceramic substrate puts it out of the ballpark for really low cost.”

The main reason the package was dropped may have been the recent development of a radically new kind of aluminum beam-lead device that’s produced by a technique far simpler than Bell Labs air-isolated, back-etched method for gold beam leads. Under the new technique, Blanchette explains, the dice aren’t etched apart at all, despite the fact that they’re formed on the wafer in an interdigitated geometry.

Devices have already been assembled by this process and are undergoing reliability tests. Blanchette is close-mouthed about how they’re made or when they’ll be introduced, but this aluminum beam-lead approach is the only one of four methods of one-shot bonding to which he has assigned a development task force. The others under study at Fairchild are gold beam leads, spider bonding for plastic-packaged flip-chips, and bumped chips for multichip packages.

The Westinghouse Electric Corp. is another firm that hasn’t yet chosen between flip chips and beam leads. Both techniques are under study at the firm’s Molecular Electronics division in Elkridge, Md., and Stephen Guthman, manager of marketing services there, says one will be chosen next year. Guthman foresees 3% to 4% of the division’s semiconductor production in face-down bonding of some type next year, 10% to 15% in 1970, and 100% by 1972.

Opposing camps

Once you get past the companies that are still studying the options, you find a host of firms lining up in support of either flip chips or beam leads, and, unlike the fence-straddlers, these advocates are quite vocal. Siding with the Hughes Aircraft Co., a pioneer in flip chips, are Intersil Inc. and Amelco Semiconductor, a subsidiary of Teledyne Inc. And a large-volume user of flip chips is the Electronics division of the Aerojet-General Corp.

On the other side of the fence, the biggest pushers of beam leads outside Bell Labs appear to be Raytheon, the Semiconductor division of Sylvania Electric Products Inc., the Semiconductor division of the Sprague Electric Co., and Hewlett-Packard Associates. Some of the firms in the beam-lead camp, Sylvania and Raytheon in particular, have in-house users who are enthusiastic about beam leads, but possibly the most important “non-captive” user is Autonetics.

After customers mention the magic words “reliability” and “cost” in citing reasons for choosing one of the technologies, they usually ask, “Can I buy devices today?” Flip-chip device manufacturers can generally give an affirmative answer more readily than can producers of beam-lead semiconductors.

The Newport Beach, Calif., operation of Hughes Aircraft has been turning out flip-chip devices on a production basis for about two years. Herbert Evander, assistant manager for microelectronics at Hughes, says beam-lead products will always cost more than flip-chip devices because of the metalurgical and processing complexity inherent in the Bell Labs process. He makes no direct comparisons on the score of reliability, however, explaining that beam leads haven’t been around long enough. He is prepared to compare flip-chip and chip-and-wire techniques on the basis of bonding labor costs to the user. For a 14-lead IC, at a labor rate of $8 an hour with standard chip-attachment techniques (ultrasonic bonding, reflow soldering), the labor content for a flip-chip device would be 3.2 cents, he says, against 11.6 cents for a comparable chip-and-wire device.

“At 250 devices per hour,” says Evander, “that works out to a ratio of from 3 to 1 to 4 to 1 in favor of flip chips.” And he adds that Hughes is shooting for bonding rates of up to 1,800 devices an hour with an automatic flip-chip bonder the company hopes to introduce in mid-1969.

The Hughes official also asserts that flip chips are anywhere from seven to 14 times as reliable as chip-and-wire devices. To support this contention, Evander cites an Air Force study of chip-and-wire
hybrids and face-bonded devices conducted at the Rome, N.Y., Air Development Center.

For chip-and-wire devices with three bonds—one connecting the wire to the contact pads, a second connecting the wire to the lead frame, and a third connecting the external lead to a circuit board—the failure rate was found to be about 0.00013% per 1,000 hours. A combination of flip-chip techniques and very close process controls yields an estimated failure rate of 0.00001% per 1,000 hours—at least as good as the rate for chip-and-wire devices with ultrasonically bonded aluminum wires and an order of magnitude better than the rate of failure for devices with thermocompression bonds using gold wires.

Close look. An electron-beam scanning microscope shows Texas Instruments' developmental beam-leded npn transistors.

It should be noted, though, that the same Air Force study gives beam leads as good a rating as it does flip chips.

Raising bumps

In "electroforming," the name given to the Hughes scheme for attaching bumps to semiconductor dice, a chrome-gold chip interconnection system is used with pure silver bumps, and a proprietary glass is r-f sputtered over the wafer along with silicon dioxide for passivation. The bumps are coated with a eutectic silver-tin alloy that has a melting temperature of 217°C.

"It's a relatively elaborate scheme," concedes Evander, "but it produces reliable devices and good bump geometry. With the silver-tin alloy, we hadn't had a case of silver migration in any of our tests. With the glass, we get a good seal to the bumps and the silicon dioxide. The devices readily pass standard military environmental tests, and you can drop them on the floor and still use them—if you can find them."

The Hughes system permits the use of either ultrasonic bonding or reflow soldering to a hybrid substrate, and it can be applied to just about any kind of semiconductor die, says Evander.

Thick chips

Amelco's flip chips for the most part have aluminum bumps that are evaporation deposited through masks and then glass passivated. Roger Murray, a senior project engineer at the company, estimates that of the 30 to 40 devices in Amelco's TTL IC line, plus npn and pnp switching transistors and "a couple of junction field effect transistors," 20 are in flip-chip form.

He says Amelco's dice are much thicker than other flip chips—9 to 10 mils compared with 4 to 5 mils for conventional dice. This thickness has both quality-control and reliability implications. According to Murray, the die isn't as flexible as thinner ones under conditions of static loading. Also, there is less chance of cracking the chip because it has a higher resonant frequency than skinner versions. "You don't decouple as much bonding energy through harmonic vibrations as you do with thinner chips," he explains.

The first products introduced by Intersil were flip chips; they made their debut about a year ago. Jean Hoerni, the firm's founder, is convinced that flip chips will become "the sustaining force of the semiconductor industry in the future."

The firm uses vacuum deposition through masks to form aluminum bumps about 1 mil high and 4 mils in diameter.

John Hall, a senior member of the technical staff, says Intersil has so far produced in flip-chip form a 20-bit, MOS p-channel shift register with a low threshold voltage, npn and pnp transistors, dual matched transistor chips, and n-channel junction FET's.

About 30% of Intersil's output is now in flip-chip form, and Hall says these devices cost from 10% to 30% more than their wire-bonded counterparts without bumps. But Intersil engineers contend that once a company is prepared to go with flip chips, the over-all cost of using them in hybrid circuits is substantially lower than that of conventional wire-bonded circuits. And the big bonus is reliability. Hall declares that the aluminum bumps give a bonding durability that far exceeds the normal requirements for ultrasonic bonding.

Because little reliability data on beam leads is available, many backers of that technology, and some neutral observers as well, fall back on intuitive feelings in contending that beam leads are potentially more reliable than flip chips. When pressed, they explain that the bonds can be seen—they can be visually checked. Flip-chip advocates, of course, find this argument meaningless.
The Big Daddy of the beam-lead team, Bell Labs, won’t let skimpy reliability data quench its enthusiasm. James Early, director of the labs’ semiconductor device and electron tube facility in Allentown, Pa., says: “We don’t have enough stuff in the field yet to make a definitive statement, but we’ve been evaluating beam-leaded circuits under a variety of conditions, and all indications are that these are the most reliable and stable semiconductor structures we’ve ever seen. Our evaluations indicate orders of magnitude decreases in degradation compared with vacuum-encapsulated circuits.”

Probably the biggest beam-lead drumbeater outside the Bell System is Raytheon. The firm’s semiconductor operation has what is probably the only contract outside the Bell organization to supply beam-lead circuits. The contract, worth $285,000 and covering components for the attack and reconnaissance radars that will go aboard the Air Force’s FB-111A and F-111D planes, was awarded by Autonetics earlier this year. It encompasses nine types of Series 100 diode-transistor-logic circuits, three kind of Series 800 TTL, and a number of RB709A linear differential amplifiers. Besides these integrated circuits, the order calls for four types of discrete diodes. The devices are being purchased in chip form (though oriented just as they were on the wafer by means of a special carrier) for use in thin-film multichip circuits.

Rudolph Thun, manager of microelectronics at Raytheon’s radar and electronics laboratory, holds that gold will probably replace aluminum in high-reliability, low-radiation applications because “aluminum is estimated to be safe for only about 10 years at current densities of 200 to 300 kiloamperes per square centimeter of conductor cross-section; some less optimistic estimates drop this density to about 80 ka. Thus you can expect to see longer-lasting gold metallization to the exclusion of aluminum in long-life IC’s, whether they have beam leads or not.”

Regarding Raytheon’s adoption of beam leads, Paul Sullivan, product manager for IC’s, explains: “You can only go so far in improving wire bonding because of the heat and pressure applied to the chip, and cost limitations militate against any great improvements in hermetic packages. So we looked for another way.”

Some variation

The Bell Labs process appealed to Raytheon, but Sullivan says his firm didn’t go all the way with it initially. “When we first started (a one-year development program undertaken early this year under the sponsorship of Autonetics and two potential in-house users), we weren’t thinking about air isolation, so we chose the term ‘flip-tab’ for our process rather than calling it beam lead in the Bell Labs sense. We’ve given the engineer an ideal situation,” Sullivan adds, “with a gold-to-gold metal system, no wires, and no heat or pressure on the chip.”

Raytheon does manual lead bonding now, but Sullivan says the process could be automated. He concedes that it’s too early to make hard predictions about output rates, but he estimates that beam-lead production should be at least four times as fast as manual wire bonding.

Sullivan says a chip-to-ship ratio (number of chips made versus the number delivered) of 1½ to 1 isn’t bad for conventional wire-bonded devices, but he believes beam leads will narrow that ratio to the ultimate 1 to 1. “With beam-lead circuits, a-c and d-c testing can be done at three temperatures at the wafer stage [Electronics, Oct. 14, p. 33], giving the user confidence that he’s starting with a good chip. And because there’s no chip damage in bonding, and because die attachment is eliminated, we visualize not only improved reliability but lower costs.”

Historically, Raytheon has tried about everything. Thun says they’ve investigated face-down (flip-chip) bonding, a technique for dropping face-up IC’s into cavities in a substrate and wire bonding, and even the application of an overlay of metalized plastic to complete circuits. Problems of reliability and alignment made these investigations “nightmarish,” he says. “We looked at all these schemes and found that beam leads made the best tradeoffs possible because much of their assembly lends itself to batch processing and there are fewer restrictions on the number of pinouts.”

Open package

Brian Dale, chief engineer at Sylvania’s semiconductor division, doubts that beam-lead IC’s will be more expensive than conventional dice once the technology reaches the production line. “There might be some dollar premium at the chip level,” he says, “but with silicon nitride and beam leads there should be none at the packaged level. Indeed, costs might fall a bit because the silicon nitride package is batch processed.”

Sylvania has thrown in its lot with beam leads after studying the technique for about four years. “We try beam leads on everything we build,” Dale says. “Two potential advantages impressed us. One was the possibility of automation; the other was the reliability of the device’s metallurgy, particularly with silicon nitride passivation. We’re trying an open package—possibly with a hole in the lid or no lid at all. This would supply the necessary physical protection, and the silicon nitride would seal the chip from the environment.”

Sprague Electric, another supporter of beam leads, agrees that batch fabrication will help keep costs in line. Robert Pepper, director of research, development, and engineering at the firm’s Semiconductor division, states: “The production steps that differentiate beam-ledged IC’s from ordinary monolithics are susceptible to batch work—nitriding, etch separation, and transfer. All are done at the wafer stage rather than at the chip stage. With semiautomatic bonding, I’d like to think that beam-ledged devices could offer the same functions as circuits with bonding pads, and at lower costs.
Analog gate’s output is cleaned up by FET

Unwanted outputs of serious magnitude can arise in bidirectional analog gates during switching by control signals. These outputs—flat-topped pulses, differentiated spikes from the leading and trailing edges of the control pedestal, or spikes resulting from noncoincident switching of the gating elements—mean headaches for the circuit designer. But the voltage-controlled resistance of a field effect transistor can overcome these spurious, superimposed signals. The result: the gate delivers smooth, clean waveforms as it’s rapidly switched by the FET.

The input signal is fed to both bases of differential amplifier Q1-Q3, and is amplified by Q4.

The differential amplifier, initially balanced by potentiometer R2, is dynamically balanced by the drain resistance of field effect transistor Q3 when the input is transmitted. This resistance is several megohms at pinch-off gate voltage, but it drops to 90 ohms when Q3’s gate is turned on. This drop provides Q3’s emitter with an a-c bypass to ground through C1, and thus unbalances the differential amplifier. Q3 conducts much more heavily than Q1, and the relative over-all voltage gain “jumps” from -40 db to 0, allowing full signal transmission.

On-off transitions contain little pedestal injection by Q3 since this transistor behaves as a voltage-controlled resistor rather than a current sink.

The Miller capacitance of Q3 passes small, differential pedestal spikes through Q3 to the output, but C2 offsets them by feeding similar spikes to Q3’s emitter for common-mode rejection. Spikes of only a few millivolts are then present at the output.
Darlington transistors widen multivibrator’s range

By F.B. Golden
General Electric Co., Auburn, N.Y.

High-gain Darlington transistors and quick-acting emitter followers can broaden the frequency range of free-running multivibrators.

Fast discharge reduces multivibrator’s rise time

By Larry V. Hendricks
Varian Data Machines, Newport Beach, Calif.

Fast removal of a stored charge keeps a single-shot multivibrator’s rise and fall times down to about 10 nanoseconds. An emitter-follower action and a strong current drive help narrow the pulses to as little as 20 nsec while maintaining stability during temperature and voltage changes.

In the quiescent state, Q₁ and Q₃ are saturated and the diode biases Q₂ off. A negative trigger of 5 volts is coupled through C₁ and turns Q₁ off. The emitter-follower, Q₁, puts a negative voltage on Q₃’s base and enhances the removal of stored charge from Q₃. At the same time, Q₁’s collector delivers a positive voltage to Q₂’s base and turns it on. The current drive from Q₂ quickens the rise time at the output.

Once the initial transient is coupled through C₁ and a strong charging current is needed through the timing capacitors, C₁ and C₂, to turn Q₁ and Q₂ on. The result: the Darlington stay on longer and push apart the frequency limits of the multivibrator. Q₃ and Q₄ ensure quicker discharge of C₁ and C₂ and, therefore, higher frequencies. Q₁ and Q₆ act as current sources making linear tuning possible.

The device can be continuously tuned over a range of 1,000 to 1 by the 25-kilohm potentiometer. If C₁ = C₂ = 250 picofarads, the frequency range is 50 hertz to 100 kilohertz. The circuit can be used as a voltage-controlled oscillator by feeding the voltage directly to the bases of Q₃ and Q₆.
and the input is held at ground, $C_1$ will discharge through $R_1$ with a time constant of $R_1C_1$. Pulses as wide as 100 nsec are obtained by adjusting $R_1$.

When $C_1$ has discharged to the cut-in voltage of $Q_1$, $Q_1$ and $Q_3$ will again saturate and $Q_2$ will turn off. The input must be held low for the duration of the desired delay, since a rise in input voltage at $Q_1$'s base would end the delay too soon.

**UJT protects op amp from voltage transients**

By R. Chapman

National Research Council of Canada, Ottawa

Large voltage transients at the inputs of operational amplifiers can make them "latch on" if the input stage saturates or can even destroy them. Connecting a zener diode across the input will not solve the problem if a high input resistance is required. A unijunction transistor connected to the input, however, can both serve as a variable threshold limiter and maintain a resistance of about $3 \times 10^9$ ohms.

The minimum threshold voltage of the circuit is determined by the ratio—typically 0.7—of the UJT's standoff ratio to its base-two voltage. If the base-two range is 3 to 35 volts, the threshold can be set from 2.1 to 24.5 volts. In the circuit shown, the UJT limits the input to 5 volts before firing. The UJT's emitter current is limited by the 100-ohm resistor.

The circuit shown limits positive-going transients only. A similar scheme, using the complementary UJT, can be used instead of or with this circuit to limit negative transients.
The circulator has been catching the fancy of more and more designers of r-f systems and circuits. Several years ago, many engineers considered circulators exclusively microwave devices, but today these versatile components are also offering solutions to many frustrating very- and ultrahigh frequency problems, such as an oscillator shifting frequency when connected to a load, or a transistor's amplifier stage breaking into oscillation during tuning.

These solutions still entail tradeoffs, of course, but with the circulator an engineer can trade less to get more. Without a circulator, the compromises were usually quite restrictive. For example, the amount of isolation required to buffer an oscillator from a load or to minimize the interaction of transistor stages had to be carefully weighed against the acceptable amount of insertion loss. And if no loss could be tolerated in the transistor amplifier or driver, the engineer could only fiddle with the tuning in hopes of getting the most out of the amplifier before a transistor was destroyed by oscillations. With the circulator, choices must still be weighed carefully, but are much less restricted.

A disk and three coils

One of the typical types of circulators is the lumped-constant device, shown schematically on page 85. It's a symmetrical, nonreciprocal element consisting of three coils wound on the ferrite disk so that the magnetic field of each coil is rotated 120° with respect to the others. Additional disks, which provide a return path for the radiofrequency fields, are placed on the top and bottom of the main one. Finally, a d-c field that biases the ferrite near ferromagnetic resonance is applied normal to the plane of the disk. The ferromagnetic resonant frequency, \( \omega_o \), is related to the bias field \( H_A \) by

\[
\omega_o = \gamma H_A - 4\pi M_s
\]

where \( \gamma \) is the gyromagnetic ratio, a constant usually taken as 2.8 megahertz per oersted and \( 4\pi M_s \) is the saturation magnetization of the ferrite material in gauss.

Without the ferrite disk, a voltage applied to port 1 would induce equal voltages in coils 2 and 3 because of the circuit symmetry. The disk makes the magnetic coupling between the coils nonreciprocal, the coupling from coil 1 to coil 2 is no longer the same as that from coil 2 to coil 1. The nonreciprocity, then, provides isolation.

Analysis of the lumped-constant circulator shows that for ideal circulation at any one frequency, \( \omega \), the following conditions must be satisfied

\[
\frac{\omega L_o}{2} (\mu^+ - \mu^-) = \frac{R_o}{\sqrt{3}}
\]

\[
\frac{\omega L_o}{2} (\mu^+ + \mu^-) \approx \frac{1}{\omega C}
\]

where \( R_o \) is the characteristic impedance, \( C \) is the capacitance in series with the coil, \( L_o \) is proportional to the inductance of one of the coils without the ferrite, and \( \mu^+ \) and \( \mu^- \) are the effective scalar permeabilities of the ferrite for positive and negative circularly polarized fields. The typical behavior of the permeabilities plotted as a function of the bias field is shown on page 85.

These equations don't completely specify the design. For example, at a given frequency, the difference between \( \mu^+ \) and \( \mu^- \) depends on where the ferrite is biased, which therefore determines how large a value of \( L_o \) is required. The choice of bias point is far from arbitrary, because the bandwidth and insertion loss of the circulator increase as the bias point gets closer to resonance. On the other hand, operating much below resonance increases insertion loss.

The equations, then, ensure good isolation at
only one frequency; at other frequencies, the isolation decreases and the insertion loss increases. That bandwidth for which the isolation is greater than 20 decibels—usually considered the practical minimum—is given by

$$\frac{\Delta \omega_{\text{in}}}{\omega} = 0.2 \sqrt{\frac{3}{L}} \left( \frac{\mu^+ - \mu^-}{\mu^+ + \mu^-} \right)$$

The minimum practical operating frequency can be expressed in megahertz as

$$f_L \approx 2.8 \times 4\pi M_s$$

Materials that are commonly used have saturation magnetization that range from less than 100 gauss to about 5,000.

Operation in the vhf region, then, requires materials that have a low saturation magnetization; for example, a figure of less than 100 gauss is required for operation below 280 Mhz. Unfortunately, these materials tend to have rather poor temperature properties, and as a result, below-resonance operation is rarely used below 1 gigahertz. Above-resonance operation suffers from reduced bandwidths, and as the circulator is operated at higher frequencies, much larger magnetic bias fields are needed.

Lumped-constant circulators have been operated from uhf down to 35 Mhz with insertion losses that ranged from 0.3 db at 400 Mhz through 0.8 db at 100 Mhz to 2 db at 35 Mhz.

Good points for operation, then, are found slightly but not much below resonance. At these points isolation decreases, but so does loss. The exact point chosen, of course, will depend on the user's specific requirements.

A nonreciprocal lumped-constant circulator, called an isoductor by Melabs, can give the circuit designer additional flexibility. Using suitable circuitry, the isoductor can provide either isolation or circulation, but, unlike the conventional circulator, it can be tuned at any frequency from 100 to 600 Mhz, as well as for impedance levels other than 50 ohms. The performance data of a triple-tuned, above-resonance circulator is shown on page 86.

Junction circulators are closely related to lumped-constant types, much as a resonant cavity is akin to a lumped-constant resonant circuit. A stripline junction circulator is illustrated on page 86.

The ferrite disk acts as a dielectric resonator; the smaller its diameter, the higher the frequency. The relatively high dielectric constant of ferrite materials—12 to 15 times that of free space—makes it possible to build circulators that, for microwave frequencies, are reasonably small. Of course, in the vhf and uhf regions, lumped-constant circulators can be made smaller than the distributed-junction types because at the lower frequencies lumped elements are much smaller than resonant cavities or quarter-wavelength matching transformers.

The circulator's bandwidth is limited by ferrite material properties but can be increased by broadbanding techniques. A bandwidth of 15% for 20 db of isolation can be achieved in a circulator without broadbanding elements. However, if additional matching circuits are used to double- or triple-tune each port of the circulator, the bandwidth can be improved from two to five times. In any case, though, an octave bandwidth is about the best that can be achieved. Typical performance data for a double-tuned microstrip circulator is shown on page 87.
Peaks and valleys. As the vswr goes, so goes the isolation. The points of minimum vswr corresponds to the points of maximum isolation in the triple-tuned above-resonance lumped-constant circulator. Although the insertion loss can be kept below 0.5 db over most of the frequency range, it does increase at both ends.

Junction circulators are built in stripline, waveguide, and microstrip configurations. They cover octave bandwidths at microwave frequencies, but are limited to about 40% at vhf and uhf. Of course, if a narrower bandwidth can be tolerated, improved performance, lower cost, and smaller size can be realized. At X band, a junction circulator using coaxial connectors has an insertion loss of 0.3 db, a voltage standing-wave ratio of less than 1.25, and an isolation of more than 20 db over a 15% bandwidth. The circulator, which is built into a half-inch cube, operates from −55°C to +70°C. Waveguide circulators offer lower loss and a better vswr than the coaxial type for the same isolation and bandwidth. For example, a vswr of 1.05 and an insertion loss of 0.1 db can be achieved over a 15% bandwidth. The waveguide type, however, at uhf and vhf is larger than an equivalent junction type.

Same result, different method

Another type, basically a transmission line loaded with ferrite, is called a resonance isolator. The ferrite is positioned so that a signal traveling in one direction does not interact with it and passes through relatively unimpeded; a signal traveling in the opposite direction does interact with the ferrite and is attenuated. In this type of isolator, the reverse signal power is dissipated in the ferrite. Still another type of circulator-isolator is the differential phase-shift circulator. It is a four-port device constructed from a combination of conventional microwave 3-db couplers and ferrite non-reciprocal phase shifters (lengths of ferrite-loaded...
transmission line in which the amount of phase shift depends on the direction of propagation in the line).

Even though the differential phase-shift circulator is larger than the junction circulator, it is used for high-power duplexers.

Since the direction of circulation depends on the polarity of the magnetic bias field, a circulator can function as a single-pole, double-throw switch simply by controlling the bias field. This field is generated either by an electromagnet or by construction of the circulator so that the d-c magnetic flux has a closed return path through a magnetic material with a square hysteresis loop.

Circulators can be latched in either of two states and switched from one state to the other. This is done by controlling the polarity of the pulse passing through the control winding of the electromagnet switching the state of the ferrite material.

Many latched circulators provide a return flux path outside the microwave part of the structure, but some have been built with the return path inside the microwave part. Doing this minimizes switching time and energy and the ferrite volume, but performance isn't usually as good as that of devices with external flux paths.

**Workhorse**

Another task handled by circulators is circulating energy from one port to the next with relatively little loss in the preferred direction while providing isolation in the reverse direction. Perhaps the most common application of this sort is a duplexer—a device that connects a transmitter and receiver to a common antenna. The circulator isolates the receiver from the transmitter energy and provides low-loss paths from the transmitter to the antenna and from the antenna to the receiver.

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**Microstrip circulator.** The coaxial connectors dwarf the ⅛-inch-diameter X-band circulator element. The "Y" of the narrow center conductor provides tight inductive coupling to the ferrite, and the large tabs add the shunt capacitance.

Circulators also couple signals to the input of a negative resistance device, such as a tunnel diode or a parametric amplifier, and couple the resulting amplified signal to the output. Since the magnitude of the reflection coefficient at the end of a transmission line can be greater than unity, if a circulator separates incident and reflected signals and controls the direction of travel of each, a two-port amplifier is the result. Usually, isolators are placed on the amplifier's input and output to ensure stable operation even with changing load and source impedances.

In another application, terminated circulators can isolate two or more communications transmitters to reduce intermodulation distortion. Without this isolation, energy could be coupled from one transmitter to the other, thus producing undesirable third-order intermodulation products.

Circulators are also used as a convenient method of phase-locking a diode oscillator to an external signal. The oscillator is connected to one port of the circulator and a low-level reference signal to another port. The oscillator is then phase-locked to the reference signal and the output is taken from the third port.

The use of integrated-circuit fabrication techniques is now enabling producers to turn out large quantities of microstrip circulators. The process, which is more reliable and reproducible than conventional methods, makes these circulators more compatible with microwave IC's.

**Bibliography**


Automating all along the line

With very little human help, computer- and tape-controlled machines make circuit assemblies faster and more reliably than semiautomatic processes

By Thomas J. Thomas
Kearfott Products Division, Singer-General Precision Inc., Little Falls, N.J.

Automation of some steps in circuit production is far from new. It usually works fine as far as it goes, but the steps that remain unautomated are often time-consuming, and human error can result in an unreliable piece of hardware.

By almost completely replacing the human element with computer- and tape-controlled machines, the Kearfott Products division of Singer-General Precision Inc., has sharply increased output and reliability of its avionics production line. Kearfott has automated all operations except the loading of machines and a few other tasks. Because the tooling is in the paper tape that controls the machinery rather than in hard fixtures, the 75,000 square-foot facility can shift production from one kind of printed-circuit assembly to another by simply reprogramming. The line turns out more than 90 kinds of p-c assemblies.

Vital element

There are three parts to Kearfott's automation: design, manufacturing, and testing of both the purchased components and the finished circuit boards. Perhaps the most important element in the system is the computer program that takes the engineer's schematic and works out the layout for the circuit boards. At the same time, the program produces some of the control tapes, develops lists of needed materials, and prints out requisition forms and purchase orders.

With few exceptions—when putting on trim components, for example—production-line workers don't touch the components, which are supplied in protective carriers or reels. They're removed by a machine only when they're to be fastened to a circuit board.

Most of the production machines were specially built for Kearfott by outside suppliers, who plan to offer similar units to the industry. These include:

- A sequencer that arranges discrete components on a belt in the order in which they're to be inserted into the p-c boards. The unit can select components from as many as 18 storage bins.
- A component-insertion machine with a servoed, adjustable head that can handle any of the parts selected by the sequencing unit. In ordinary insertion machines, the head must be changed each time the size of the component changes. This means that a separate pass must be made over the p-c board each time a different type of component must be inserted. First the machine inserts the resistors, then the capacitors, and so on. The new machine, made by Universal Instruments Corp. of Binghamton, N.Y., handles any mix of components so that all parts can be inserted in a board in one pass. This saves not only time but also space on the production line, because a single machine can do the job of several. Components can be inserted at a rate of up to 1,800 per hour. At most, a standard circuit card—6 by 3.8 inches—has 75 components and 45 flatpacks on a side.
- An automatic reflow soldering machine that selects any of up to 14 different types of integrated circuits from feed bins, then fastens them automatically to a circuit board. The fastest conventional soldering machines are semiautomatic; an operator must position either the soldering head or the circuit board, transport each IC into place, and press a button to solder.

The cards are used in the analog-digital converters and control panels in the advanced avionics package for the F-111D fighter and FB-111 fighter-bomber, the navigational computer for the P-3C early warning aircraft, and the converter for the A-7D/E Corsair II attack aircraft.

Two programs

The components on the engineer's schematic are fitted into a layout at Kearfott's Little Falls, N.J., facility by two computer programs. One, supplied
by ITT Data Services, Paramus, N.J., clusters the IC elements, such as gates and flip-flops, to minimize the number needed. Then the program decides in which IC's the elements should be placed.

The second program, developed by Singer's Friden unit in San Leandro, Calif., takes the clustering and placement information, with the rest of the circuit details, and routes the wiring. Interconnection crossovers are kept to a minimum and components are positioned—generally with their axes pointed in one direction—so they can be easily placed on the board by the automatic equipment.

Soon, both parts of this procedure will be brought together in a single program that will also minimize the number of plated-through holes in the circuit board. These holes are a potential source of unreliability because extra steps, such as plating and eyeletting, are required to produce them. Sharply reducing plated-through holes minimizes the chance that a manufacturing variable, such as hole-etching time, photo-exposure time, or humidity, may be inadequately controlled.

To make the boards even more reliable, Kearfott doesn't use a multilayer design. It uses a board with a 50-mil-thick aluminum core. The rigid core acts as a ground plane and heat conductor.

An engineer uses the Friden program by keying into the computer the types of components in his
schematic and how they're interconnected. The computer is also told the dimensions of the p-c card and the coordinates of areas where components and interconnections may not be placed. The computer program then does the rest, using standard widths for signal and power lines. Ten mils is a good width for signal lines, 30 mils for power lines.

Film direction

The artwork for photoetching the patterns on the circuit boards is developed from the layout. Currently, this is done manually by an operator at an automatic drafting machine made by the Mergenthaler Linotype Co., a division of the Eltra Corp., N.Y. The rough layout from the computer is used as the basis for precisely locating lines and hole patterns. The operator selects the patterns from a library of slides within the machine, which then produces the layout pattern by photographically exposing a Mylar film. The artwork is completed by a technician, who very carefully puts down opaque black tape.

This machine, called a Diagrammer, and its operator will be replaced by an automatic machine developed by the Superior Electric Co., Bristol, Conn. Numerically controlled, the SNC100 Photo-optical Positioner System produces one-to-one artwork masters for the p-c boards. The base price of the positioner is $26,000, from $40,000 to $170,000 less than numerically controlled drafting machines already on the market. The price is low because the machine is designed for generating artwork, not for general-purpose drafting.

The new machine consists of two basic parts: an off-the-shelf three-axis numerical controller that Superior sells for controlling tools such as drills and milling machines, and a precision x-y plotting table with an optically focused light source. The table can travel over an 11-by-18-inch rectangle. This is a considerably smaller area than is usually covered by the general-purpose drafting machines, so the positioning and environmental controls are simpler.

Mylar film or a glass master is fastened to the table underneath the light source. In front of the light is a disk with 66 apertures shaped in straight lines, pads, or circles. Light shines onto the film through an aperture selected by the control tape, which comes from the layout program.

As the table moves, the film is exposed. Line widths ranging from 5 to 300 mils can be traced on the film to an accuracy of ±1 mil. The control program also adjusts the intensity of the light to maintain line clarity as the table changes speed. Kearfott has produced photographic masters on 4- and 7-mil Mylar film and on glass.

Drill instructor

The control tape that generates the artwork can also be used for drilling and eyeletting the boards. The tape formats for controlling the machines are the same. It's also possible to prepare by hand a tape for controlling the artwork generator; the input is obtained from a grid-paper layout of the p-c board.

Right now, drill tapes are produced by fastening the master artwork from the Mergenthaler Diagrammer onto a precise x-y positioning table and focusing a closed-circuit television camera on it. An operator, looking at a greatly enlarged part of the artwork in the tv monitor, positions a set of cross hairs precisely in the center of each hole by moving the x-y table. He then presses a button, and the control tape for the drill is punched out.

A television system that can work in a fairly
low light level is used; a conventional optical reader's light could distort the Mylar artwork masters. Glass masters, which could withstand the heat, are 3 to 10 times as expensive.

With some additional information—such as the type and size of the components to be inserted in the hole—the drilling-machine tape is used to produce tapes that control the sequencing and insertion machines.

The sequencer puts the components on a reel in the order they're to be used; the reel is then fed into the insertion machine, where the program tape anticipates the size and shape of the component about to be put into the board. Automatically adjusting the size of the servoed insertion head, the tape commands the head to grasp the component and insert it. The machine also bends and crimps the leads, clipping them onto the back of the card.

Production is speeded if a circuit board has either all discrete components or all flatpacks. Every board with flatpacks, however, requires at least two resistor-capacitor networks for clipping line transients. The components are inserted first, the board is wave-soldered, and then the IC's are reflow-soldered in place.

Six-second solder

The programed reflow soldering machine, developed for Kearfott by the Weltek division of Wells Electronics Inc., South Bend, Ind., solders up to 14 leads on an IC flatpack in a single heat cycle. The IC's come from the supplier tinned and cut to size. Each IC comes in a special two-piece carrier that Kearfott, because it buys so many units, was able to design and insist on receiving.

This carrier, consisting of a holder and a small, pop-off cap, is compatible with the production-line machines. The IC rests in the holder, secured by the cap. Two prongs coming up through the bottom of the carrier easily pop the cap off so that the IC can be lifted out by a vacuum head. The caps on most of the other carriers on the market were designed to be removed by hand.

In the soldering machine, IC's are arranged in as many as 14 different feed magazines. The p-c card on which the IC is to be soldered is held flat on an x-y table. A transport mechanism selects an IC from the bottom of a magazine and shuttles it to a pickup station, where the cap is popped off. The vacuum head lifts the flatpack out of the carrier and places it down onto the programed pads on the circuit board, which has been moved into position by the table. The reflow soldering head, made of a beryllium-copper alloy that retains little heat, holds the leads in position while the heat is automatically applied. A blast of air cools and hardens the solder quickly.

Until this machine was developed, production-line soldering devices were semiautomatic, requiring an operator to position the circuit card and initiate the soldering action. One type of IC was worked on at a time by hand. An experienced operator can solder one IC to a board in about 30 seconds, but the automatic machines take only six seconds.

Another different aspect of the new machine is that the flatpack leads aren't crimped before being soldered. (The crimp is made to help an operator solder the leads.) The leads are left straight and, on the finished board, have a slight bow. This bow, unlike a crimp, doesn't put any stress on the hermetic seal and allows for differential expansion of the seal and lead materials.

Quick tests

All the discrete components are electrically tested while they're still in the reels they're supplied on. A reel handler feeds the components into a Fairchild 4000M programed component tester that handles up to 1,800 discrete devices per hour. Components that fail the tests are cut out of the reel automatically. A flatpack handler feeds the Fairchild tester with up to 400 IC's per hour.

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Electronics | November 25, 1968

Circle 93 on reader service card 93
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<table>
<thead>
<tr>
<th>RATINGS</th>
<th>TH. 302</th>
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<tr>
<td>HEATER VOLTAGE V</td>
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<tr>
<td>OUTPUT POWER W</td>
<td>25*</td>
<td>100*</td>
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<tr>
<td>INTERMODULATION LEVEL dB</td>
<td>&gt; 52</td>
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Integrated electronics

Large-scale problems in LSI testing

As arrays become increasingly complex and fast, producers and users scamble to develop and program computer-based systems that will make adequate checks

At the moment, companies involved in testing large-scale-integration devices agree on little beyond the fact they have problems. Among the biggest headaches: deciding what to test, programing computer-controlled systems, determining the validity of results, and achieving higher operating speeds. One observer—Al Schmitt, director of the computer laboratory at Litton Industries Inc.'s Guidance and Control Systems division—goes so far as to say: "There isn't yet enough knowledge about LSI testing to spot trends or even hold long-range opinions."

Schools of thought. While a majority of firms favor functional testing, there's at least one vocal and articulate advocate of one-shot checks: John C. Hubbs, president of E-I1 Research Laboratories Inc., Oakland, Calif. In one-shot testing, a pulse is applied to a single pin at a time, and its speed through the device is measured; in functional checks, test systems put a pulse on every input and sense every output simultaneously.

Hubbs, whose firm makes pulse generators and other solid state test equipment and systems, says one-shot checks are the only practical way to pinpoint problems. "If a test reveals only that a device is no good without indicating which of its many gates has failed, then the production department's going to have a tough time discovering just where the process went wrong," he says. "From the standpoint of information, a functional test provides only a 1 or a 0, but a parameter test furnishes a much more valuable real number."

By way of example, Hubbs points out that if the turn-on time for a gate is 5.2 nanoseconds and the turn-off time 3.2 nsec, it's possible to say the threshold level is too far toward the 1 state. "The military is vitally interested in this sort of testing," he says, "because it can tell something about devices' life expectancy."

Majority views

Few, if any, experts in the testing field fully accept Hubbs' views. For instance, Gordon Padwick, applications manager at the Instrumentation division of the Fairchild Camera & Instrument Corp. in Sunnyvale, Calif., feels the technique's accuracy is open to question. The fast pulses used aren't actually measured; they are converted into voltage and stretched. "Small swings—on the order of 50 millivolts—are hard to measure through the 50-ohm impedance of a probe," says Padwick.

In any case, says Padwick, propagation delays are not always as critical as they are in, say, the central processing unit of a large computer. He's sold on functional

GI issue. General Instrument's LSI test system includes, from left to right, a teletypewriter, PDP-8 computer, company-built test set, probe station, and device-control unit; firm is working on a new version to up 2-Mhz speed.
... at this stage, no one really knows what kind of LSI tester they want...

testing: "It's the key sorting parameter now and will be even more so with LSI devices." Hubbs' rejoinder is that his company is building testers only slightly more expensive than those used to check 14-pin integrated circuits. "As the world moves toward medium-scale integration, it can do nothing but fall in our lap," he says.

The principal elements of E-H's test system for LSI are a strobing voltmeter, switching time converter, timing unit, and pulse driver. Hubbs concedes that his company faces "an uncomfortable squeeze" as devices get more complex and faster. There's a problem in getting from any of three pulse generators to any of 45 pins without going through a transport matrix, where bandwidth may be 20 nsec. Accordingly, the firm recently bought Automated Measuring Corp. to help develop elements for a new scanning system.

Pragmatism. Fairchild, along with Texas Instruments Incorporated and most other LSI makers, stresses testing of devices in the environments in which they are designed to operate. Dale Williams, who heads advanced development activities at Fairchild Instrumentation, points out that IC's that fail to meet a particular specification can be peddled to less demanding customers. "With LSI, each circuit will be different, and we won't be able to do this," he says.

As a result, Williams believes high-speed devices will have to be tested at speed. Fairchild already offers a tester, the 5000A, that can handle devices with up to 144 pins, but it operates at only 10 kilohertz. The company's Instrumentation and Semiconductor divisions are at work on prototype equipment that will improve on this rate. But Padwick says frankly: "It's very unlikely we're building the system everyone's waiting for. At this stage of the LSI game, we really don't know what it has to look like. All we can do now is make decisions and back them with money."

Other firms are in much the same position. In fact, when the General Instrument Corp. and American Micro-Systems Inc. wanted to test assemblies at 2 megahertz, they had to undertake the building of their own equipment at costs in the hundreds of thousands of dollars.

Smith brothers

GI, which is noted for its skills in MOS technology, turned the tester project over to twin brothers, K.D. and K.F. Smith, at its Research and Development Center in Salt Lake City. They designed and built a system that's now on line at the company's Hicksville, N.Y., plant, and have begun work on a second-generation configuration. The operational equipment consists of: a Digital Equipment Corp. PDP-8 computer; a company-built test set—in effect, another computer that administers the tests and determines whether a circuit is good—a probe station for wafer tests, and a device-control unit for packaged circuits. The system has 12 channels; it will test circuits with 12 inputs, 12 outputs, 4 clocks, 2 power supplies, and 1 reset, at a 2-MHz rate. This is clearly neither big enough nor fast enough for true LSI devices, so the second-generation unit will be built around a PDP-9, which will permit testing more devices with more leads.

The operational tester runs a specific test pattern, loaded by the computer into a 320-bit shift register, and compares the actual and expected outputs, providing go/no-go evaluations. With a separate 320-bit test pattern, this routine is performed for every test. While this doesn't appear to be particularly tricky, GI had to decide just how many tests to run. It eventually settled for testing every gate at least once—but not necessarily every combination of gates. "I feel that there is an optimum set of frequencies, loads, and logic states to test," says K.D. Smith. "But this is purely intuitive."

Range. The operational model compares not only logic but also logic amplitude at the output; it can also make a number of static tests for leakage and current monitoring. K.D. Smith wants to make
more d-c tests in the new system now being built. For instance, he wants to know the on impedance for multiplexers; to this end, he will force current into the test device and measure the voltage across the switch.

He also wants to measure current down to 0.1 nanoamp—as against 100 na in the present version. There will also be a new technique for measuring threshold voltages; the present system uses a reference voltage. To measure thresholds at specified currents, he will use a current/voltage technique in which current can be sourced or sunked at any terminal and the corresponding voltage measured.

He anticipates a problem testing complex devices at speed. CI is already producing MOS devices that operate at 10 Mhz, he says. The four-phase logic they use has two bits of overlap between the clocks, a situation that requires six bits of information to strobe a four-clock system. This means the strobing circuitry must be operating at 60 Mhz. "MECL or the new SUHL might handle this," he says. "But it might be better to make most tests at slow speeds and then run a special speed test." Harold Vitale, an engineer working on LSI at Fairchild Semiconductor, agrees.

He points out that a device can be given a special test for speed, in which all inputs are held at a certain state with a fast series of clock pulses being applied. After a given number of pulses, the outputs can be sensed to determine if they are in the proper state.

On and off line

The Semiconductor Products division of Motorola Inc., is also developing an LSI tester for its own use that will be in action before year’s end. It is reportedly 100 to 1,000 times faster than available systems. The equipment, designated EC-34, can handle both bipolar and MOS arrays; it includes a Motorola-built central computer that uses MECL-2.

One of the key features of the EC-34 is the use of programable pulse generators rather than relay matrixes to speed testing. The unit will eventually be able to test devices with up to 120 pins, but at the outset 60 pins will be tops. George

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<tr>
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<tbody>
<tr>
<td>single NAND gate</td>
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<tr>
<td>dual gate expander</td>
<td>FJJ101</td>
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Witsell, manager of IC equipment engineering, says Motorola is making parts now that go into 60-pin packages—full adders, parity trees, counters, and shift registers.

All compilation, logic simulation, specification generation, and test reduction are done off-line in the Motorola system. "This feature is important in LSI testing," Witsell says. "Otherwise, the test computer would be wasting a lot of time. We're determining off-line what we have to test—the minimum number of tests we have to make based on certain assumptions about how many are needed to determine if we have a good device or not. The computer reduces the total of tests to a reasonable number—maybe 10,000, although we haven't had to do that many yet."

The EC-34 tests only propagation delay among a-c parameters now; a future version will also measure rise and fall times. "We measure only go/no-go on propagation delay, but the ability to measure it at full test speed is unique," Witsell maintains. The machine, however, can data-log most d-c and a-c parameters by successive approximation at a slower speed, he says. "We can do d-c and a-c go/no-go testing at 8 microseconds per functional pattern. If we want to data-log a parameter, we have to slow down to 12-test cycles (96 nsec)."

**Artistry**

Another sophisticated LSI tester is being readied for use by the Raytheon Co.'s Missile Systems division in Bedford, Mass. Dubbed RATS (for Raytheon Automated Test System), this setup, according to Richard Norman, senior engineer at the division, will be able to make a-c and d-c checks of bipolar arrays, as well as performance checks of hybrid circuits built from several MSI chips. Early next year, the system will have a wafer dynamic testing capacity—an attractive feature in view of the company's interest in beam leads.

Perhaps the most intriguing characteristic of RATS, however, is the integration of mask-making into the IC test program. "Our system prints out actual values of circuit performance," says Norman. "It's not just a go/no-go device—but a flexible engineering tool useful in design as well as production control."

Ironically, Raytheon was originally aiming for a comparatively simple system without a computer capability. "But it just grew like Topsy," says Norman.

**Best bet.** As for determining what to test and the validity of results, most producers exhibit varying degrees of resignation. For example, James McPhail, who designed the American Micro-Systems tester, says: "You can no longer probe into a (black) box. Your only access is the input/output pins, and you need a thorough test as possible." The rub, of course, is what constitutes thorough in the face of the staggering number of possibilities for testing in LSI circuitry.

"We use the old win formula—will it work," says L.J. Sevin, MOS-product manager at TI. Computer programs are far enough along so that large logic arrays can be simulated to check validity, he says. Litton's Schmitt, however, pinpoints the development of diagnostic programs for testing large arrays as a major problem.

**The money goes.** Looking for the black cat in the dark room is costing LSI makers and instrumentation houses a nice piece of change. Except for E-I, which says it produces operational equipment for less than $100,000, most systems makers' investments run into the hundreds of thousands of dollars. Says AMI's McPhail: "When we tried to get instrumentation companies to build test equipment, they really socked it to us with ridiculous bids. Prices ran up to $75,000 for the word generator alone and were close to a half-million dollars for the whole tester." However, most observers agree "the ballpark" extends from $150,000 to $300,000.

And the consensus is that it will be hard to lower these figures appreciably. "When you order steak, you have to pay," says Texas Instruments' Sevin. "It costs more than hamburger."
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Multiple exposure showing typical waveform aberrations for positive and negative polarities at various amplitude settings. Notice the constant risetime and falltime with amplitude changes. 20 ns/cm sweep time and 4 V/cm deflection factor.

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Space electronics

Ground-station market flies high

Orders increase as prices and hardware needs decline; optimists expect demand to continue through 1975, but others see a crest coming up fast

By Paul A. Dickson
Washington regional editor

Ground stations for satellite communications are springing up around the world like mushrooms after a spring rain, and a brisk controversy over the size, shape, and staying power of the market is growing right along with them. Some observers believe demand for costly, large-scale installations is near a peak. Others, whose ranks include hopeful contractors of varying nationalities, anticipate a high level of demand for both big facilities and small, transportable setups through at least 1975.

No one can deny that business is booming at the moment. By year's end there will be 22 ground stations operating commercially around the globe. A dozen more are in various stages of construction, and contracts have been let for another four on which work will begin within the next few months. Using information gleaned from fellow members of the International Telecommunications Satellite Consortium, the Communications Satellite Corp. estimates that as many as 45 facilities will be on the air within the next year and a half. But as far as one Comsat official is concerned, the story ends right there. "We're witnessing the zenith of ground-station contracting and construction," he declares.

Best teacher. This source says the price tags on ground stations are coming way down as contracting agencies, as well as electronics firms and other suppliers, gain experience in the field. A few years ago, it took upwards of $8 million to build a good-sized facility; the cost is now down to between $4 million and $5 million. And the next generation may go for around $3.5 million.

"The satellites are better and there's no longer a need to overbuild," says the Comsat official. "We've learned, for example, that we don't need elaborate steering mechanisms for the antennas since the satellites are in synchronous orbits. In addition, we've eliminated sight towers, using the stars to calibrate the systems." The use of parametric amplifiers, rather than masers, with station receivers affords another significant cost saving, as does the use of more Spartan cooling systems. And since radiation feedback problems have proved less severe than originally anticipated, antenna dishes have been moved in close to the stations, eliminating up to a quarter mile of cabling, along with such associated electronic items as waveguide and amplifiers.

For all: the cuts in prices and truncated shopping lists, a number of observers believe the market for ground stations and related hardware will wax rather than wane in the next few years. One such is D.N. Steel, sales manager for space and special projects at Page Communications Engineers Inc., a Washington-based subsidiary of the Northrop Corp. "Ground stations give a country—particularly an underdeveloped one—added political freedom," he says.

Steel points out that African communications still follow the old lines of colonial trade. Thus, for example a call from Lagos, Nigeria, to Nairobi, Kenya, must be routed through London. Similarly, calls between one-time French possessions go through Paris. "These countries and others like them want their own stations so they can cut these ties," Steel says.

Orders and reorders. A number of nations—Algeria, Israel, Sweden, Switzerland, the United Arab Republic, and Turkey, among others—are scheduling their first ground stations for the 1970-72 period. In addition, Steel says, many countries already plan to supplement facilities that have yet to be built. For example, a request for proposals from the government of New Zealand is now making the rounds; it calls for the installation of antenna dishes and related hardware at four more cities after the island's first station goes on the air in 1970. And three East African nations that have contracted for a communal facility recently announced that they want another in 1972. "As
This high-precision laboratory oscilloscope equals the basic performance of higher priced, sophisticated 'scopes, yet meets the industry need for such performance in the $600 price range. Emphasis has been placed mainly upon those characteristics most important in precise measurements, eliminating some of the more exotic and somewhat superfluous functions found in higher priced instruments. The result is an all-solid-state instrument in the medium price range with extraordinary stability, sensitivity, bandwidth, sweep-speed range, trigger capability, reliability, and ruggedness.

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- Positive, solid triggering on all displays
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Contenders. The fact that there's a boom on in this field has not been lost upon the world's industrial giants. Jenkins, whose department furnishes technical advice to such lands as Chile, the Philippines, Peru, Jordan, Taiwan, Pakistan, Spain, Kuwait, and Venezuela, estimates that some 15 firms around the world are scrambling for a piece of the ground-station action. And new entries are crowding in, he says, pointing to Japan's Tokyo Shibaura Electric Co. and West Germany's AEG-Telefunken. Among the others who have been vying for orders are:

- Page, which has built stations for Comsat, the National Aeronautics and Space Administration, and the governments of Panama and Australia. The company recently won contracts for installations in Iran and Lebanon, and is after jobs in New Zealand and Pakistan.
- Canada's RCA Victor Ltd., which has just entered the field but is off to a good start with a contract for a station in India.
- The Hughes Aircraft Co., which, after a string of successes, stubbed its toe in Peru earlier this year [Electronics, March 4, p. 307].

primitive economies develop, requiring more and better communications services, there will be a greater demand for ground stations and related equipment," says Steel.

John Jenkins, assistant manager of Comsat's technical advisory department, agrees. "Early starters are now considering second systems," he says. "The ground-station market will continue to grow through 1975."
The General Telephone & Electronics Corp., which has been comparatively inactive during the last year after winning three straight prestige contracts.

Japan's Nippon Electric Co., which has an edge in Asian outlets because of its proximity, technical competence, and access to financing.

In time, however, the number of firms in the field will shrink as the market matures. For one thing, the decline in the going rates for installations will make the business a survival-of-the-fittest proposition. For another, technological expertise is not the sole prerequisite of success. "A number of supplementary services are involved," says A.E. Sutter, vice president and senior director of marketing at Page. "Underdeveloped nations often need help in financing multi-million-dollar ground stations, and you've got to know your way around the international money markets to handle this sort of thing."

More for the money

"A traditional rule of thumb in communications is that once a system is operating, it's saturated," says Comsat's Jenkins. He contends this proposition will be particularly true in the case of satellite ground stations, with the start-up of one facility creating a need for more.

Installations for domestic satellite networks will, in Jenkins' opinion, prove a huge market over the long run. He points out that the...
proposed Canadian system [Electronics, Sept. 4, 1967, p. 131], which has just received Intelsat's blessing, will require 30 stations. And the on-again, off-again net proposed for the U.S. calls for 35. Ground stations for domestic systems will cost between $250,000 and $500,000 apiece—a far cry from even the bargain-priced facilities now being erected—but Jenkins notes that it's a volume market with plenty of growth potential.

Right now, Pakistan is as close as any country to implementing a domestic system; it plans two stations at either end of its divided territory to permit free communications. And Page's Steel reports that Brazil, India, and Australia, among other countries, are also interested in putting in domestic systems.

In for a penny, Sutter of Page reasons that the decline in the going rate for the biggest ground stations gives more nations a chance to buy them. Moreover, he believes initial installations will motivate governments to expand their communications horizons. "Once a nation has good international communications and realizes the backwardness of its local distribution, it's likely it will take steps to improve the setup in its own backyard," he says. "This will tend to encourage construction of domestic and regional systems, as well as second and third stations for the international net." His colleague Steel notes that the French have already been talking with a number of African countries about establishing a central system.

In the meantime, a number of companies are working on the development of low-cost, transportable ground stations. Prospective applications include provision of communications to and from remote construction sites, disaster areas, and the like. One of the concerns investigating such stations is the General Electric Co. Richard Hesselbacher, manager of communications systems at GE's Missile and Space Systems division in Valley Forge, Pa., says his organization is particularly interested in portable systems designed around antenna dishes as small as 20 feet in diameter.

From the ground up. Recently, the division was awarded a NASA...
contract to study the possibilities of a direct broadcast system with the pint-sized dishes. At the same time, it's working on a potential television experiment for the space agency's Applications Technology Satellites F and C. This experiment would require the development of a low-cost ground station that could be assembled and put on the air by unskilled labor in a remote village in India to receive a tv signal from the satellites. The idea is to demonstrate that such systems are practical even in areas lacking in technological resources.

At the moment, NASA and GE are working with an umbrella-like antenna 15 feet in diameter and made of honeycomb Mylar. A version of this antenna was tested aboard the aircraft carrier Essex in connection with the Apollo 7 flight. Color pictures of the splashdown were transmitted from the ship via this unit.

**Hostile environment.** Transportable ground stations do, however, face some opposition. A couple of years ago, Intelsat published guidelines for its stations specifying that antenna dishes be 85 feet in diameter or larger. But even these giants fell short of the anticipated mark, and 95-foot dishes are now the norm. Enforcement comes down to a matter of economics; the consortium charges the proprietors of nonstandard systems more for satellite time. There's a certain rough justice in this procedure since, officials point out, a 42-foot dish, for example, requires 6.5 times more of the satellite's capacity than an 85-foot unit; a 30-foot installation requires 27 times as much. Charges are levied proportionately.

So far, nonstandard configurations have been used largely on a one-shot basis. A small station built by the Hughes Aircraft Co., for instance, was used to get Olympics coverage to the furthest reaches of the Pacific Northwest and Canada.

Intelsat is now looking into the question of which countries might require transportable ground stations and for what purposes. Officials hint that if there are sizable enough requirements, modifications may be made in future spacecraft to accommodate smaller ground antennas. However, no determination is expected before the end of next year.

---

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New Products

Consumer electronics

IC audio amplifier puts out 5 watts

By raising the supply voltage and improving the thermal mounting, GE turns the trick in this monolithic device without increasing size

Raising the power output of an integrated circuit doesn’t have to mean increasing the size of the IC, as device designers have demonstrated in a new power amplifier.

Retaining the basic plastic dual in-line package of previous 1-watt and 2-watt IC’s (the PA234 and PA237), designers in the General Electric Co.’s Semiconductor Products department were able to provide the new PA246 audio amplifier with a power output capability of 5 watts continuous into a 16-ohm load with less than 5% total harmonic distortion.

They did it by increasing the maximum power supply voltage rating to 37 volts—thus boosting power without also boosting heat-generating current—and by modifying the thermal mounting to increase the power dissipation capability of the package. The chip is mounted directly on the lead frame, instead of being first mounted on the metal feed strip used in the earlier, lower-power versions. And the tab area (for mounting an external fin or other heat sink) has been increased. The net result is that the PA246’s dissipation is rated at 5 watts with the tabs at 70°C. (At the 5-watt output level, it’s dissipating about 3.5 watts.)

Elimination of the metal feed strip used in the lower-power IC’s makes the automated fabrication process more complicated, since the chips now have to be fed individually instead of from a roll of strip. However, the presence of the extra layer of metal between the chip and the lead frame added too much resistance to the thermal path from chip to heat sink, and would have prohibited the 5-watt dissipation rating. The chip assembly operation has been modified to provide vacuum pick-up of each chip, and automatic positioning of it on the lead frame. Almost simultaneously, the chip is welded to the lead frame.

GE engineers say that 5 watts output isn’t the limit for the new thermal design. They believe that a family of IC’s will evolve, with ratings up to 10 watts.

Two markets. The PA246 is the first monolithic IC that can produce this signal output power, according to GE. Sinclair Radionics Ltd. has advertised a similar IC in British publications at a retail price of $7.15. But the Plessey Co., which will make the IC for Sinclair, has run into technical problems, and it will be several months before the circuit is in production [Electronics, Nov. 11, p. 306].

The Sinclair-Plessey IC has some specifications that are superior to those of the PA246. Its frequency response, for example, is 5 hertz to 100 kilohertz, ±1 decibel, versus 30 hertz to 100 kilohertz, ±3 dB, for the PA246. With a sensitivity of 5 millivolts and power gain of 110 dB, the British IC is a preamplifier as well as amplifier. However, the package is slightly larger (1 x 0.4 x 0.2 inch versus maximum dimensions of 0.770 x 0.280 x 0.160 inch), and the heat-sink tabs are considerably larger, thicker, and heavier.

GE expects the biggest market for the IC to be in radio, phonograph, and tape recorder equipment, but also sees sizable industrial sales. The circuit can function as a servo amplifier, operational-amplifier booster, or relay driver, for example. The price is “under $2 in volume quantities,” notes Anthony Desiderio, sales planner for consumer microelectronic markets. In quantities of 100 to 999, the unit price is $2.56. It’s available in sample quantities in 30 days.

The plastic package has eight leads in a staggered arrangement to provide a mounting-hole spacing...
of 140 mils on the printed-circuit board. The two copper tabs extending from the package can be attached to an external heat sink when the circuit board is flow-soldered.

In a phonograph application, the PA246 accepts the approximately ½-volt signal from the pick-up. For external components, it requires two input resistors, one input capacitor, four output resistors, and two output capacitors. The IC chip itself is about 60 mils and contains seven transistors, five diodes, and four resistors.

The IC can operate from any supply voltage up to its maximum. Although it's designed for a 16-ohm load, other load impedances can be used with a slight drop in efficiency. Frequency response extends from 30 hertz to 100 kilohertz, and noise output is typically —70 decibels relative to 5 watts. Input sensitivity is 180 millivolts and output harmonic distortion is less than 1% at the rated output.

Specifications
(measured in test circuit illustrated)
Supply voltage 37 volts max
Output current 1.25 amps max
Dissipation (tabs at 70°C) 5 watts max
Storage temperature —65 to +150°C
Operating temperature —55 to +125°C
Input voltage for Pout=5 watts
Rs = 0.6.8k
Re = 6.8k
Efficiency for Pout=5 watts
Distortion at 1 kHz 5 watts
Output quiescent voltage at pin 7
Quiescent current 17 mA typical
0.7% typical

Semiconductor Products department,
General Electric Co., North Syracuse,
N.Y. 13213 [338]
If Noise Is Your I/C Problem... MHTL is The Economical Answer!

A recently-expanded line of integrated logic circuits that provides 6-volts (typ) noise immunity is now available in hermetically-sealed, dual in-line ceramic packages at the same price levels as previously-announced types in plastic.

It's called MHTL*—for Motorola high-threshold logic. And, because of the six new circuits in the line — bringing the total to ten — the designer has much greater latitude in high noise-immunity system implementation.

MHTL is an ideal family for use in numerical control, supervisory control and computer-peripheral equipment. It's also valuable for interfacing with discrete components. In addition, MHTL offers a voltage swing of 13 V, over a wide operating temperature range (−30° to +75°C), high fan-out and 30 mW power dissipation.

—where the priceless ingredient is care!

Here are the ten devices and functions:

<table>
<thead>
<tr>
<th>TYPE</th>
<th>DESCRIPTION</th>
</tr>
</thead>
<tbody>
<tr>
<td>GATES</td>
<td>Expandable Dual 4-Input Gate (active pullup)</td>
</tr>
<tr>
<td>MC660L</td>
<td>Expandable Dual 4-Input Gate (passive pullup)</td>
</tr>
<tr>
<td>MC661L</td>
<td>Triple 3-Input Gate (passive pullup)</td>
</tr>
<tr>
<td>MC670L</td>
<td>Triple 3-Input Gate (active pullup)</td>
</tr>
<tr>
<td>MC671L</td>
<td>Quad 2-Input Gate (passive pullup)</td>
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<tr>
<td>MC668L</td>
<td>Quad 2-Input Gate (active pullup)</td>
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<tr>
<td>DRIVER</td>
<td>Expandable Dual 4-Input Line Driver</td>
</tr>
<tr>
<td>MC662L</td>
<td>Dual J-K Flip-Flop</td>
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<td>FLIP-FLOPS</td>
<td>MC663L</td>
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<td>EXPANDER</td>
<td>MC664L</td>
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<tr>
<td>EXPANSER</td>
<td>MC669L</td>
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Electronics | November 25, 1968

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Autonetics Division of North American Rockwell
New Components Review

Trimming potentiometer model 325 measures 0.435 x 0.250 x 0.150 in., and weighs 0.5 gram, yet meets or exceeds MIL-R-27208. It has an operational temperature range of -65° to +200° C, and is rated at 1/4 w at 85° C. Wiper design assures constant positive contact with resistance windings, Atorn Electronics, 3030 Empire Blvd., Burbank, Calif. [345]

Rotary variable differential transformer 7149 has 48 null positions over a rotation angle of 360°. Carrier output voltage phase angle alternates between 0° and 180° from one null position to the other. Output voltage envelope is similar to a triangular function. All windings are in the stator, with no moving contacts. Pickering & Co., Sunnyvale Blvd., Plainview, N.Y. [346]

Character generator tube TH9503 is a fast generator of letters, figures, signs or symbols. While in monoscopes the signal corresponding to the complex picture is obtained by scanning the whole target at each frame, here the signal corresponding to the figure chosen is obtained by scanning 1 at a time among the 64 signs shown. Thomson Electric Co., 50 Rockefeller Plaza, N.Y. [347]

High voltage capacitors type CKM2 are packaged in rectangular CPTO cases with solder seal terminals that assure a true hermetic seal. They come in ratings from 500 to 50,000 v, and operate from -55° to +85° C without derating. Tolerance is ±20%. Dissipation factor does not exceed 0.8% at 1,000 Hz, ±25° C. Film Capacitors Inc., Eighth St., Passaic, N.J. [348]

IC op amp compressed into flatpack

Double-substrate ‘sandwich’ construction of hybrid permits use of both thick- and thin-film resistors

The 14-lead flatpack is mowing down competing packages right and left. The blade began to swing with hermectics but picked up most of its force with the advent of integrated logic circuits in plastic packages. Now there’s a booming business in circuit boards tailored to fit 14- and even 16-lead flatpack elements.

With such emphasis on the small centipede-like flatpack, potential users look down on “cumbersome” packages as much as 1.12 inches square—especially when they’d like to save money by putting all their components in flatpack-style circuit boards.

"So it’s coming down to the problem of designing op amps to fit 14- or 16-lead IC flatpack sockets," says Robert S. Cook, a mechanical design engineer for Philbrick-Nexus Research, a Teledyne subsidiary.

The company’s new model 1404 micropower op amp, though similar in many ways to its year-old Q-200, required some engineering hand springs to get the circuitry—once housed in a 0.72-cubic-inch package—into the 0.07-cubic-inch flatpack.

The new op amp can be used where low quiescent current is re-
Over the years Radio Materials Company has maintained its leadership in the production of ceramic disc capacitors. A complete line offering outstanding quality has been the key to continuing growth.

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Soldier-In
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For application in equipment where lead inductance effects must be reduced to an absolute minimum.

If your application requires special physical or electrical characteristics, contact RMC's Engineering Department.

Tiered. Double layer widens resistance range of unit as well as saving space.

required—in battery operation, for example, where little energy can be wasted. Remote, unattended seismic sensor systems may be one such application. A quiescent 1404 typically draws only 50 microamps.

To “compress” the op amp, Philbrick-Nexus used both thick- and thin-film hybrid technology, devising what may be one of the first “hybrid-hybrid” IC’s.

A relatively large alumina substrate—0.46 by 0.75 inch—forms the base of the circuit. It has connections for the pins that will lead out of the package, a cermet thick-film resistor network, and chromium circuit interconnections.

Epoxy on alumina. A smaller alumina substrate is glued over the first one. It's placed atop the cermet resistor network and insulated from it by epoxy adhesive.

On this second layer of circuitry are the active components of the op amp, including 10 to 20 transistor chips, about 20 resistors, and three capacitors. Thin-film interconnections make a circuit out of these elements, and wire bonds like those used in IC packaging connect the upper and lower substrates.

Space and volume weren't the only reasons for going to a double-substrate system. According to senior engineer Arnold M. Liberman, it was impossible to get the wide range of resistors needed on a single substrate. "We needed from 27 ohms to 1.8 megohms. Originally we tried to realize the circuit in thick film alone but found it too bulky. And thin films couldn't give us some of the resistances we needed. So we combined the two techniques."

And David Ludwig, chief engineer, adds: "Use of both thick- and thin-films gives us the benefit of two realms of cost, accuracy, and resistance. Thin films allow precise but low resistances but at a
Motorola's Frequency Control Products are now on the market.

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For additional information on existing products and design potentials, write to Motorola Communications & Electronics Inc., 4501 W. Augusta Boulevard, Chicago, Illinois 60651. Ask for Bulletin TIC-3401.
Choose from 44 styles of film capacitors... There's one to meet your exacting requirements.

...three-layer hybrid may be tried next...

higher price than thick films, which offer less precise but higher resistances.”

Normally, Ludwig says, the 1404 would amplify or condition signals before transmitting them to an analog-to-digital converter. Its usable demand current of up to 3 milliamps is big enough to simplify the choice of an a-d converter.

Because of component matching, both at room temperature and (for critical transistors) over wide temperature ranges, the 1404 achieves a typical common-mode rejection of 90 decibels and a minimum of 75. This, says Ludwig, is easily within the range usually associated with discrete-component op amps.

For flexibility of operation with various power supplies, the 1404 can work with input voltages ranging from 2 to 15 volts, “and it could probably handle 17 or 18 without strain,” according to Liber.

Shake or break. How strong is a device in which a ceramic substrate doubles as a header? Very strong, according to Ludwig, who says the 1404 passes shock and vibration requirements of MIL-S-19500, “and these are pretty demanding specs.”

“Certainly, the 1404 is tougher than other layered hybrid schemes now in the lab,” says Ludwig. “In some of these the substrates would be separated by posts, so each could flex with respect to the other and possibly break. But by using epoxy as the center of our sandwich, we get two layers of alumina to reinforce one another, while the epoxy absorbs some minor stress in between.

“It's possible that we might try three-layer circuits of this type, but since bonding pads are needed at the edge of each successive layer, the topmost substrate soon gets pretty small—or the bottom one very large. In either case, it looks like three layers is near the point of diminishing returns.”

Although no price has been set for the 1404, Philbrick-Nexus says sample lots will be available in a month.

Philbrick-Nexus Research, Allied Dr. at Rt. 128, Dedham, Mass. 02026 [349]

Dearborn Electronics, Inc.
(a subsidiary of the Sprague Electric Company)

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Electronics | November 25, 1968

Circle 119 on reader service card 119
New components

Fuse blows in a millisecond

Fast unit can protect IC's, power transistors in digital microcircuits

They went shopping for fuses to go with a line of digital power components, but engineers in the microcircuit operation of Beckman Instruments Inc.'s Helipot division couldn't find devices that were fast enough.

The speediest 0.5-amp fuses took from 8 to 20 milliseconds to open a circuit, says George Smith, supervisor of product design, "and an 8-millisecond fuse isn't fast enough."

So Beckman developed the 817 series, a line of fuses rated at 0.5, 0.75, and 1.5 amps. All three types blow in 1 millisecond. "This is with a small overload," says Smith, "It can get as fast as 50 nanoseconds with a 30-amp overload," which he says is not unusual.

Power problem. "The components we're worried about—the integrated circuits or power transistors—are downstream from the voltage regulator, but we're not too concerned about overvoltages," Smith notes. "It's power dissipation that's a problem. Power can produce destructive temperatures rapidly. The thermal time constant of one of our voltage regulators is 1 millisecond. This means that it reaches 63% of its final temperature in that time, and we need to shut down the system in 100 to 300 microseconds."

The new fuses, housed in TO-46 cans, consist basically of metal wires made of a high-temperature alloy and another proprietary material developed at Beckman. Operation is said to be stable at temperatures from -55°C to +125°C.

Prices for all three types range from 85 cents in quantities of 50 to 99, to $1 for one or two fuses. The fuses are guaranteed at 100% of their ratings for 1,000 hours.

Helipot Division, Beckman Instruments Inc., Fullerton, Calif. 92634 [350]
CARPITRON
(Locked carcinotron)

The carpitron is an oscillator which can be locked by a drive signal in an electronically tunable band.

The range covered by the existing types is 500 to 18,000 MHz.

With output powers:
2 kW to 100 Watts

Main features:
- Small size
- Bulk structure
- High efficiency
- Low supply voltages
- Low noise performances

Applications:
- Output tube for space telecommunications ground stations.
- Tropospheric scatters
- DOPPLER radars.

Examples

CMP 1115 (Developed for Intelsat ground station at Pleumeur-Bodou)
Frequency range ................................................. 5925-6425 MHz
Output power .................................................. 500 W
Instantaneous bandwidth .................................. 45 MHz
Equivalent gain .............................................. 16 dB
Efficiency ...................................................... 35%

F 4190 (For KU band)
Frequency range ................................................. 15-18 GHz
Output power .................................................. 100 W
Instantaneous bandwidth .................................. 80 MHz
Equivalent gain .............................................. 20 dB
Efficiency ...................................................... 15 - 20%
You design RF circuits in terms of frequency domain.

Now you can measure their performance that way, too.

Forget all equipment limitations that used to plague signal analysis in the 1 kHz to 110 MHz range. The HP 8552A/8553L Spectrum Analyzer has all the characteristics—absolute calibration, high stability, freedom from internal distortion and spurious responses—that make it an indispensable tool for virtually every frequency domain measurement.

Absolute signal levels are displayed from -130 dBm to +10 dBm (0.07 μV to 0.8 V). With the wide 100 MHz scan, you see the broad spectrum quickly, precisely. Reduce the scan width in calibrated steps (to as narrow as 2 kHz) for detailed examination of individual signals. With the analyzer’s distortion-free 70 dB dynamic range and narrow 50 Hz resolution, you can characterize complex signals, even in the presence of other high-level signals.

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Your HP field engineer can give you the details on how this remarkable new instrument can solve your frequency domain measurement problems, in circuit design lab or final system evaluation. Or write to Hewlett-Packard, Palo Alto, California 94304; Europe: 54 Route des Acacias, Geneva.

HEWLETT-Packard
SPECTRUM ANALYZERS

Electronics | November 25, 1968
New Instruments Review

Direct-recording, light-beam oscillograph model LCR provides a complete analog recording system with built-in signal conditioning modules matched to single-unit galvo-magnet structures. Its servo drive system has 8 recording speeds ranging from 0.1 to 80 ips. The oscillograph features 3, 8 or 14 channels. Midwestern Instruments Inc., 6422 E. 41st St., Tulsa, Okla. [361]

A rear panel local oscillator output is now available as an option on all versions of interference analyzer model EMC-25, a solid state RFI/EMC swept receiver covering 14 kHz to 1,000 MHz. The 1-0 output spec is for a minimum of 100 mv into 50 ohms and levelled to within 25 mv for all bands up to 25 MHz. Electro-Metrics Corp., 88 Church St., Amsterdam, N.Y. 12011 [365]

Ratiometer model C/XT4070 will accurately measure carrier level to noise power density ratio to within 0.1 db. Wide measurement bandwidth (40 MHz centered at 70 MHz) is obtained by utilizing the differential precision of a waveguide beyond cut-off attenuator, and a true RMS detection system. FKS Communications Inc., 3 Delaware Drive, New Hyde Park, N.Y. 11040 [366]

Integrating digital multimeter DT-360 features 5 functions and 5 ranges, including a-c voltage and current. Zero and full scale calibration adjustments are made through the front of the meter; the pots are located behind the easily-removed identification strip. Unit price is $450. Data Technology Instrument Co., 1050 East Meadow Circle, Palo Alto, Calif. 94303. [363]

A-c/d-c voltmeter 1002 is a 5-in-1 instrument. As a differential voltmeter it is designed to provide d-c accuracy ±0.0025% of reading and ±0.05% a-c accuracy with a reference stability of 2 to 3 ppm. It can also be used as a decade voltage divider, ratiometer, calibrated reference source, and null detector. Precision Standards Corp., Box 8361, San Marino, Calif. [362]

A-c/d-c differential voltmeter model TDV-1000 offers 1 ppm linearity and resolution, d-c accuracy of ±0.0005%, a-c accuracy of ±0.05% and a stability of better than 0.0025% in 60 days. D-c range is 0.0000 to 1100.0 v; a-c is 0.001 to 1,000 v. Operating temperature range is 0° to 50°C. Price is $1,985. Julie Research Laboratories Inc., 211 W. 61st St., New York [364]

Precision calibrator model B38A is for rapid and accurate calibration of telemetry f-m subcarrier discriminators. It internally generates all 121 of the 7½% narrow-band and all 8 of the 13½ wide-band proportional IRIG f-m subcarrier channels as well as four selectable tape speed reference frequencies. Monitor Systems Inc., 401 Commerce Drive, Fort Washington, Pa. [367]

Pulse generator PG-22 is an all silicon instrument featuring rise and fall times better than 2 nsec, rep rates from 0.1 Hz to 50 MHz, and wide range control of pulse width (30 nsec to 1 sec) and delay (−10 nsec to +1 sec). Simultaneous positive and negative outputs are independently variable up to 5 v into 50 ohms. Lyons Instruments Ltd., Hoddes- don, Herts., England. [368]

New instruments

Pulse generator takes to the field

Battery-operated unit, the size of a six-pack, directly drives RTL, DTL, and TTL circuits

If an engineer buys a portable oscilloscope, chances are he also needs some portable test gear. So goes the reasoning behind International Contronics Inc.'s decision to build a battery-powered pulse generator.

"Tektronix realized the need for an oscilloscope that could be used in the field and other places where a-c power requirements couldn't be met," says Contronics' president, Charles Chapin. "And it continues to amaze me that Tektronix doesn't provide a complementary d-c pulse generator."

Wide and fast. Both the pulse width and repetition rate are adjustable.

Electronics | November 25, 1968
New... a deposition thickness controller you can trust—always

Now, Airco Temescal has eliminated misleading readouts caused by elevated temperatures, sudden thermal shocks, electron beam sources, and close substrate-to-evaporant spacing. And, we have not added a cent to the sales price—$1150. Available from stock.

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- Long life
- Wide dynamic range
- Stable operation
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Ideal for protection of magnetron modulators, microwave stations, d.c. power systems, output of d.c. power supplies, all types of signal and data transmission lines, p.c. protectors, control circuits. Available from stock or custom designed.

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... select any frequency
from 1 Hz to 10 Mhz...

Tektronix Inc. doesn't, so Contronics does. The Lochpulse generator weighs 6 pounds, is as big as a six-pack, and runs for 3½ hours off a 5-volt nickel-cadmum battery. It's the first product made by Contronics, a new company organized by a group of former Fairchild engineers.

Designed to work with the Tektronix 422 oscilloscope, the Lochpulse has two complementary, d-c-coupled outputs. Pulse amplitude is continuously adjustable up to 5 volts, as are pulse width, from 50 nanoseconds to 20 milliseconds, and repetition rate, from 1 hertz to 10 megahertz.

Rise and fall times are both typically 6 nsec when the instrument feeds a 50-ohm load. The maximum for both is 10 nsec.

The Lochpulse can feed almost any digital system; it directly drives resistor-transistor, diode-transistor, and transistor-transistor logic circuits.

No delay. Lochpulse, says Chapin, is the first portable pulse generator built with TTL integrated circuits. By using these IC's, Contronics engineers were able to give the instrument a 100% duty cycle without using delay lines.

TTL circuits are also used in the Lochpulse to generate repetition functions and to control width and output.

The company expects the generator to be used on ships, where the available a-c power is often too noisy for digital testing. Chapin also points out the commercial and military demand for equipment to test airborne navigational and data-handling systems.

There are three models of the Lochpulse. The 200-3 runs on a-c only and costs $335. The 201-1 is a-c/d-c, but its pulses have constant amplitude; it sells for $310. The 200-2 is a-c/d-c and has adjustable amplitude; it costs $335.

When a Lochpulse runs off a-c power, it works with 105-to-125-volt signal at 50 to 400 hertz and draws up to 10 watts.

Delivery time for all models is one week.

International Contronics Inc., 106 Terra Bella Ave., Mountain View, Calif. [369]
why should the only cargo that loads itself be toughest to ship?

Getting you to and fro has been a series of outright blunders, slow-dying half-measures, and scattered bits of good ideas.

The trend in surface commuting, for example, is for more and wider roads with more and fatter cars carrying fewer persons. The logical extension is an infinite number of empty cars, hub to hub and dent to dent, on a 15-mile circle of asphalt centered on each community.

We think system engineering can bring order to this chaos, and we intend to be there when it happens. What system engineers have done so far has been merely practice for what lies ahead.

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Tell us how you would take advantage of these opportunities in an atmosphere like this: engineering innovation as a way of life, systems the business of everyone, and the individual as contributor.

WRITE TO Mr. James L. Hackbush, Sanders Associates, Inc., Dept. 467E, 95 Canal St., Nashua, N. H. 03060.

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With Tamron... on TV...
the picture is getting brighter, all over the world

Tamron Lenses

<table>
<thead>
<tr>
<th>No.</th>
<th>Focal Length</th>
<th>Aperture</th>
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<tbody>
<tr>
<td>1224</td>
<td>12.5-50mm</td>
<td>1 : 1.8</td>
</tr>
<tr>
<td>1624</td>
<td>16-64 mm</td>
<td>1 : 2.0</td>
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<tr>
<td>15210</td>
<td>15-150 mm</td>
<td>1 : 2.5</td>
</tr>
<tr>
<td>2024</td>
<td>20-80 mm</td>
<td>1 : 2.5</td>
</tr>
<tr>
<td>2524</td>
<td>25-100 mm</td>
<td>1 : 1.8</td>
</tr>
<tr>
<td>1214</td>
<td>12.5 mm</td>
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<td>7519</td>
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</tr>
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Tamron lenses for ITV at moderate cost for high quality and proven performance. Matching the most critical requirements of the world's leading TV camera makers and users, they are especially appreciated for high resolving power, freedom from aberration, superior radiation intensity, and no mechanical vignetting.

Manufactured by Taisei Kogaku, known particularly as the world's ZOOM specialist, Tamron lenses are generally designed to be equipped with manual, gear-driven and motor-driven systems.

Tamron CCTV lenses are members of the famous Tamron family of optics in the fields of X-ray, process, electrostatics copying, micro film, etc.

Tamron ITV lenses provide the full range from Super-Wide angle through 10:1 Zoom.

New instruments

Steady heat for under $100

Proportional controller handles 15-20 amps; can be used for speed

Regulating an oven shouldn't be an off-and-on affair. It's inefficient to be continually shutting down and starting up an oven as the temperature jumps back and forth across a set point.

This is one reason makers of diffusion chambers, industrial furnaces, and other constant-temperature systems prefer proportional control— as temperature nears the set point, the voltage that controls the heating system changes in an attempt to stabilize the temperature. Another reason is that proportional control permits more precise regulation.

Off-on systems cost less, of course, but PMF Electronics Inc. has built a proportional controller that sells for less than $100. Thomas Richardson, president of the company, says similar devices cost at least $250. He credits the low price to the use of circuitry produced for other PMF controllers and to the fact that the new device handles 15 to 20 amps, against about 600 amps for competing devices.

Called the Mark III-VP, the device is a meter-relay, and comes in ranges from 100°F to 2,500°F. The

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DIP-MOLD PROCESS CUTS POTTING TIME 60%

Microtran Company, Inc., Valley Stream, N.Y., produces a wide variety of miniaturized and standard transformers, many specified with epoxy encapsulation. When dipping transformer bodies in epoxy proved slow and otherwise unsatisfactory, a shell-mold process was adopted, using Cerro® low-melting-point alloy. Here's how Microtran cut potting time, in some instances from 47 to 18½ minutes, and improved its product as part of the bargain: Cerrotran Alloy melts at a safe 281°F and expands (.0005"/inch) as it solidifies. A master pattern of polished aluminum, dipped into the molten alloy, yields almost instantaneously a shell mold of accurate dimensions and excellent surface finish. The transformer is placed in the shell; epoxy is poured in and air-cured. Such molds are used once and are broken off. The alloy can be reused indefinitely. Reverse curves and undercuts are readily accommodated by making the molds in matched halves. Shell molding is only one of many uses for Cerro low-melting alloys. For the full story on their versatility, call Cerro Alloy Dept., Cerro Copper & Brass Co., Rolling Place, Stamford, Conn. 06907. Telephone (203) 327-0550.

In Europe, contact Mining and Chemical Products, Ltd., Alpertont, Wembley, Middlesex, England.

... if temperature goes up, Mark III's output goes down...

set point is adjustable, and the proportioning band can go from 5% to 15% of full scale.

Triac control: Input to the Mark III comes from a thermocouple; the temperature-sensitive signal drives the voltmeter, which is scaled to read out in Fahrenheit or centigrade. Attached to the meter's needle is a plastic cylinder; as the needle moves, the cylinder rotates. Behind the meter are a lamp and a photocell. The rotating cylinder changes the amount of light reaching the cell, so the cell's resistance is proportional to the oven temperature.

The current in the cell controls a transistor that, in turn, determines the gating current of a triac. This triac's output, which is proportional to the gating current, flows back to the oven where it drives the heating system.

Because of the low current capability, Richardson expects makers of small ovens to be his first customers. He also feels that the Mark III has a place in process control systems, like those used for injection molding and die casting.

And the Mark III can also be made to keep temperature from falling too low. "We've already sold some of these for use in cryogenic surgery," says Richardson.

If a tachometer instead of a thermocouple feeds the Mark III, the device can be used to proportionally control speed.

Dimmer display. The Mark III runs off 115 volts a-c. Its front panel is 4 by 4½ inches, and its barrel is 3½ inches long.

Besides the meter, there are two knobs and a lamp on the front panel. As the triac's output changes, the lamp brightens or dims. One of the knobs is used to fix the set point, and the other to set the width of the proportioning band. This second knob is attached to the shaft of a potentiometer that's in parallel with the photocell.

PMF can build in an integrated-circuit amplifier for the millivoltage signals coming from the thermocouple.

PMF Electronics Inc., 124 E. Third St., Dayton, Ohio 45402 [370]
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New Semiconductors Review

Fast-firing SCR's series 81RLA feature inrush currents of 800 amps/sec. They can be turned on with 100 ma gate drive. The combination of epitaxial process, including contour groove and shorter emitter construction with accelerated cathode excitation, provides the ideal fast firing parameters. International Rectifier, 233 Kansas St., El Segundo, Calif. 90245. [436]

Single diffused, intermediate frequency silicon power transistors have current ranges from 3 to 90 amps. Features include capability to resist second breakdown, moderate frequency and power cut-off frequency beyond audio range. Applications include power supplies, audio power stages, series and shunt regulators. Solltron Devices Inc., Blue Heron Blvd., Riviera Beach, Fla. [440]

Ten n-channel dual FET's, 2N5515 through 2N5524, have ultra-low noise and tight matching for improved differential amplifier applications. They contribute less than the equivalent thermal noise of the signal source from 100 Hz to 10 kHz for generator resistance of 5 ohms to 1 megohm. Units come in a 6-lead TO-18 package. Siliconix Inc., 1140 W. Evelyn Ave., Sunnyvale, Calif. [441]

Varactor and p-i-n elements have been developed for use in microwave IC applications. An element consists of a chip mounted on a bonding pad, providing the circuit designer with greater flexibility. P-i-n elements are available for low power switching, phase shifting, limiting, duplexing, and modulation. Microwave Associates Inc., Northwest Industrial Park, Burlington, Mass. [437]

High frequency characteristics are specified and guaranteed as transistors series 35800 designed for microwave hybrid circuits. They are recommended for use in critical oscillator and amplifier applications. Typical f0's for the series are 3 to 4 GHz. Small quantity prices range from $65 to $80. Hewlett-Packard Co., 1501 Page Mill Road, Palo Alto, Calif. 94304. [442]

Advanced MOS/LSI 3751 is a 12-bit analog-to-digital converter containing all the logic and system timing circuitry needed for building a successful approximation type of A/D 36-pin dual inline package. The design features parallel or serial output capability. Price in lots of 1 to 24 is $144 each. Fairchild Semiconductor, 313 Fairchild Dr., Mtn. View, Calif. 94041. [439]

New semiconductors

High-voltage transistor switches fast

Rated at 180 volts, it turns on in 1.5 microseconds; device designed for airborne power-conversion jobs

Designers of airborne power supplies know that high voltages usually require sacrifices in transistor efficiency; higher saturation voltages and slower switching.

But engineers at TRW Semiconductors have developed a power transistor that is rated at 180 volts at 80 megahertz and can handle peak surges of 50 amps yet has almost the same saturation voltage and switching speed as the 30-amp, 100-volt transistor TRW introduced last spring [Electronics, May 13, p. 159].

The 180-volt 2N5584 switches in fast operator. Transistor for avionics handles high voltages without sacrificing switching speed.

Electronics | November 25, 1968
ORGANIZE!

132 can be used with data-handling crt's...

1.5 microseconds, and TRW will guarantee a saturation voltage of 0.4 volt at 10 amps. At 20 amps, the saturation level is 1.5 volts, and the device has usable gains to 50 amps. Robert Austin, assistant plant manager for power products, says other high-voltage transistors usually have a saturation voltage two to three times higher.

The trick, Austin says, was designing the emitter periphery of the interdigitated device in such a way as to sharply reduce the current per unit area. He adds that close control of diffusion techniques yielded the 80-Mhz cutoff frequency.

TRW says the new transistor is well suited for high-efficiency airborne power-conversion equipment, such as high-power inverters operating in the 50-kilohertz region, and for data-taking cathode-ray tubes in which switching speed is important.

Helpful companion. A 1N5409 high-speed, 40-amp rectifier will be sold as a companion device for the inverter applications. This 35-nanosecond rectifier is needed, Austin says, because the efficiency of a transistor in a high-frequency system is wasted if the rectifier is slower.

Like all TRW's power devices, the 2N5584 is designed for radiation resistance. "We're trying to become experts in power-conversion equipment," Austin says, "and radiation resistance is often a requirement, so the metalizing material we use doesn't have a high atomic mass and isn't affected by radiation." He adds that radiation hardening also strengthens reliability.

The transistor is designed to withstand the same high-temperature reverse-bias life testing—100-watt power and 100°C case temperature for 1,000 hours—as components that TRW supplies for strategic missile systems.

The 250-mil-square chip is housed in a TO-63 can, is available in distributor quantities, and costs $105 for orders of one to 99.

TRW Semiconductors Inc., 14520 Aviation Blvd., Lawndale, Calif., 90260 (444)

WE MAY ALREADY HAVE DESIGNED THE SILICON RECTIFIER ASSEMBLY YOU WANT

Tung-Sol packages a lot of performance into silicon rectifier stacks. Thorough experience in heat sink configuration, control of transients and the manufacture of solid state devices, assures highest efficiency in units that require only minimum space. Power capability is extremely broad.

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Speed ECCSL, Ultra-Low-Power
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Mil Spec Scope K-106 (AN/USM-117)  
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GENERAL ATRONICS

Circle 173 on reader service card

Circle 134 on reader service card
New Books

Wide appeal

Fundamentals of Integrated Circuits
Lothar Stern
Hayden Book Co., Inc.
176 pages, $8.95

This is one of those books that an engineer can recommend to his technician for a good background on the subject. Or, for those engineers who haven't become familiar with integrated circuits, this text will be a good start. And even those deeply involved in IC's might appreciate the chance to step back and get perspective on the whole forest.

Stern writes well, gets right to
the point, and clearly outlines
the tradeoffs and problems. The only fault that might be found is
the lack of color in the drawings
that explain the diffusion steps; the various schemes of cross-hatching
don't clearly delineate the areas.

The book covers basic semiconductor theory, monolithic and film circuits, hybrid circuits, packaging, design, and layout principles, and ends with a discussion of large-scale integration that includes discretionary wiring and computer-aided design.

It also includes a good
glossary—there's nothing more frustrating
than coming upon an unfamiliar
term and then trying to find where
the author used it first to get his
definition.

Recently published


A broad view of waves, instabilities, and other nonuniformities; magnet design as applied to MHD generators; design considerations; scaling laws; and space applications. This is both a reference and a text for engineers new to the field. Stressing practical applications of plasma physics, it includes discussions of the thermodynamics of power cycles and of the use of nuclear and chemically fueled MHD generators for electric power, for special scientific and military purposes, and for space propulsion.


A guide to program writing, this book describes the scientific and technical applications of higher-level languages and their relation to commercial data processing. It also covers such peripherals as magnetic tape and disks, line printers, and card readers and punchers.

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This complete single-card A-to-D converter includes reference supply and comparison amplifier, using dual in-line integrated circuit logic with a MINIDAC D-to-A module. It accepts 0 to +10 volts input range, and provides up to 12 bits resolution.

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Technical Abstracts

Under strain
A thin-film diode strain sensor
Robert M. Moore and
Charles J. Busanovich
RCA Laboratories
Princeton, N.J.

A strain sensor must be light and flexible enough to present a negligible mechanical load, yet sufficiently sensitive to reflect a small change in strain by a large change in output. These properties are realized in a thin-film, p-n heterojunction diode fabricated by vacuum-evaporation technology. This device also acts as a low-output-impedance voltage source—a big plus in most applications—and has a low-pass frequency response of up to 2 megahertz.

The sensor can be formed on a variety of substrates selected for their mechanical properties. Three that have been used are 0.001-inch-thick plastic, 0.005-inch aluminum, and 0.040-inch glass.

The typical heterojunction combination is n-type cadmium selenide deposited on p-type selenium, the whole being only 40 millionths of an inch thick including top and bottom electrodes.

In operation, the heterojunction diode is forward biased. Strain induces shifts in the forward current-voltage characteristic; tension makes the I-V curve rise more sharply and compression makes it rise more slowly.

The I-V characteristic resembles that of a vacuum triode, but the controlling parameter is mechanical strain rather than grid voltage. The sensor therefore acts as an electromechanical triode.

Voltage output of a typical sensor shifts 250 millivolts for an applied strain of \(5 \times 10^{-4}\); in other words, sensitivity is 500 volts per unit strain. This "typical" device has an active area of 2 by 6 millimeters and is operated at a bias of 10 milliamperes and 1.6 volts. The differential resistance at this bias point is 50 ohms, giving a gauge factor of 1,000—five times larger than that of single-crystal silicon piezoresistive devices.


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New Literature

Magnetic tape degausser. Ampex Corp., 401 Broadway, Redwood City, Calif. 94063. Description and specifications of the model SE-20 automatic magnetic tape degausser, designed for telemetry, radar, and other high-precision recording applications, are contained in data sheet D105. Circle 446 on reader service card.


Zener diodes. Motorola Semiconductor Products Inc., P.O. Box 955, Phoenix, Ariz. 85001. Application note AN-437 contains comprehensive information on the characteristics, testing and reliability of temperature-compensated zener diodes. [449]

Straight cable plug. Sealector Corp., 225 Hoyt St., Mamaroneck, N.Y. 10543. Product bulletin CX-119A describes the SRM straight cable plug for use with 0.141-inch-diameter semirigid coaxial cable. [450]


Chart papers. Houston Instrument division of Bausch & Lomb Inc., 4950 Terminal Ave., Bellaire, Texas 77401, has available a four-page bulletin describing the various 2-fold chart papers that can be used on the Complot digital plotters. [452]

High-vacuum facilities. Thermonics Laboratory Inc., 22864 Sutro St., Hayward, Calif. 94544, offers an eight-page brochure describing its facilities for high-vacuum evaporative coatings, brazing, and leak detection services. [453]

Ultrasonic transducers. Phillips Mfg. Co., 7334 N. Clark St., Chicago 60626. Product bulletin 120 includes descriptions and specifications for both the end-fitting and bulkhead-fitting models of immersible ultrasonic transducers. [454]

Cable assemblies. Star-Tronics Inc., Moulton St., Georgetown, Mass. 01830, has released two engineering data sheets describing flexible and semirigid cable assemblies. [455]
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New Literature

High-power amplifiers. Radio Engineering Laboratories, 29-01 Borden Ave., Long Island City, N.Y. 11101. Three technical data sheets describe high-power amplifiers for satellite ground subsystems. [456]

Incremental shaft encoders. Disc Instruments Inc., 2701 South Halladay St., Santa Ana, Calif. 92705. Five applications for Rotaswich incremental shaft encoders are described in bulletin 456. [457]

Xenon arc lamps. Radiarc Inc., 526 N. Garfield Ave., Monterey Park, Calif. 91754. A four-page technical brochure describes xenon arc lamps. [458]

Semiconductor processing equipment. Fluoroware, Chaska, Minn. 55318, offers a catalog containing full information on a wide variety of products for handling substrates, wafers, and crystals. [459]

Microwave filters. DeMornay-Bonardi, division of Datapulse Inc., 1313 N. Lincoln Ave., Pasadena, Calif. 91103. New interdigital and combline microwave filters offering excellent electrical characteristics under severe environmental conditions are described in technical data sheet DB-358. [460]

Recorder/reproducer. RCA/Defense Electronic Products, Moorestown, N.J. 08057, has issued an eight-page brochure on the PT501 series of wideband, 4-to-6-megahertz precision recorder/reproducer. [461]

Relays. Universal Relay Corp., 42 White St., New York 10013. Catalog 968 lists hundreds of types of micro miniature, subminiature, telephone, aircraft, mercury wetted, differential, polar, sensitive, impulse, latching, vacuum, high-voltage, timing, sealed, resonant, stepping, and other relays. [462]


Proportioning control system. Blue M Electric Co., 138th & Chatham St., Blue Island, Ill. 60406. A four-page bulletin describes the company's Power-O-Matic 70 solid state control system and various units equipped with it. [464]

Laser data chart. Laser Nucleonics Inc., 123 Moody St., Waltham, Mass. 02154, has available a laser data compilation chart that measures 22 by 24 inches and folds so it can be put in a notebook. [465]

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Space chiefs decide to keep ELDO alive

The bruised and battered European Launcher Development Organization, beset by financial troubles caused by Britain's defection, has gotten a new lease on life. Europe's space ministers meeting in Bonn have decided to stick with ELDO until 1971 when its current activities are to culminate with the launching of the Europa 1 and 2 rockets.

But the conferees cut out development of apogee motors in an attempt to stay within the program's new limits of $626 million. They also called for studies of a post-1971 program to develop launchers for heavy stationary satellites.

Britain, which has announced its intention of dropping out of ELDO after 1971, came up with an alternate plan at Bonn. In exchange for an immediate release from its ELDO obligations, it offered to participate in a group combining the functions of ELDO and the European Space Research Organization. The proposed organization would build a television satellite and a big data-relay satellite, and also carry out long-range applied research. In other words, the British were saying that booster development is a waste and that the money should go to building satellites that could be launched by U.S. rockets. But the decision to go ahead with ELDO's program seems to make the British proposal academic.

Ion implantation pushed in Japan

The Japanese government has earmarked nearly $2 million to help its electronics industry catch up in the area of ion implantation. Both Toshiba and Hitachi Ltd. will receive $900,000 contracts to develop, in Toshiba's case, ion-implanted transistors capable of operating up to 6 gigahertz, and in Hitachi's case, implantation techniques for the continuous fabrication of 30 transistor wafers an hour.

The subsidies will come from the Research and Development Corp. of Japan, a government-owned organization set up in 1962 to help the nation's industries attain their scientific and technological goals.

Philips takes aim at computer sales

Philips Gloeilampenfabrieken, which only recently introduced its first commercial computer, is aiming to push computer sales to the point where they'll account for 10% of its total sales by 1973. Based on a predicted revenue of $2.86 billion that year, this would amount to $286 million of computer volume. Philips' 1968 total sales are estimated at about $2 billion.

In announcing this goal, the huge Dutch firm insisted that it's not out to battle IBM head to head on the Continent.

East Germans try advanced switching

The East German electronics industry, ranked right behind Russia's in the Eastern bloc, is apparently making big strides in telephone exchange technology. An experimental installation in East Berlin incorporates thin-film circuits in its control current loops and reed contacts for voice switching. The system, called ETS 700, was designed and developed by VEB Fernmelderwerk Arnstadt.

The installation is the country's second electronic exchange system. The first, turned over to postal authorities last year, was an international effort with East Germany as system manager. That project included the
Soviet Union, Poland, Hungary, Bulgaria, Czechoslovakia, and Rumania. East Germany is so heavily engaged in the telephone exchange field because it is ideally situated to be a base for interface systems between electronic exchanges in the West and conventional ones in the East. That's why East Berlin, a major city fairly close to other big ones in the West, was chosen over Moscow or Warsaw as the site of the socialist bloc's first electronic exchange system.

Toshiba sues Shiba in vtr patent case

Toshiba has tackled another opponent in its continuing battle with other Japanese makers of video tape recorders. The firm has filed a suit charging the Shiba Electric Co. with infringing on its helical-scan vtr patent. Besides seeking damages, Toshiba is asking that Shiba be barred from further production of the disputed recorder, a double-head model.

Toshiba's action is based on a 1959 patent issued specifically on a single-head recorder but also mentioning multiple-head designs. Whether it applies to recorders such as Shiba's, with two heads at 180° to each other, can only be settled by litigation.

To complicate matters, Shiba in 1963 asked Toshiba for a license under its patent. Before Toshiba could decide, Shiba broke off the negotiations, and said it would develop and sell a recorder that did not infringe on Toshiba's patent. Toshiba now not only claims infringement, but asserts that Shiba acted in an unprincipled manner in unilaterally ending the negotiations. Shiba denies both charges.

Meanwhile, on its other patent battlegrounds, Toshiba says it has reached an agreement with Sony and is holding talks with other manufacturers, including the Matsushita Electric Industrial Co. and Matsushita's subsidiary (and competitor) the Victor Co. of Japan.

Intelsat 'cordial' to Canadian plan

It now appears that the proposed Canadian domestic satellite system will not run into any significant opposition from Intelsat. At a recent closed-door meeting of Intelsat's interim committee on satellite communications, the Canadians presented their plans for the system, which would be the first domestic satellite hookup.

According to one participant at the meeting, the proposal was "cordially" received by the delegates, although no formal vote was taken. Under existing Intelsat rules and in most of the proposed changes to them, a member nation needs Intelsat's blessing to start a commercial satellite communications system.

Japan's spring tax bears autumn fruit

A change made last April in Japan's tax on television sets is now being reflected in steadily increasing production of 14-inch, monochrome transistorized sets. Until April, all transistor receivers were exempt from the country's tv excise tax—15% for screen sizes through 20 inches, 20% on sets with screens 21 inches and up—based on factory prices. The exemption was aimed at promoting solid state technology, which in Japan is without the benefit of any government-subsidized military or space projects.

The modified regulations still exempt transistorized sets with screens 14 inches and up, but impose a 5% levy on those with screens 12 inches and smaller; the government felt that the smaller solid state sets were competitive enough to get along with a narrower tax advantage. The result is that manufacturers now find they can sell a 14-inch set for almost the same price as a 12-inch, so they're introducing more of them.
Great Britain

Thin solar cells

As satellite power requirements soar, the additional size and weight of the solar-cell arrays needed to provide that power are becoming millstones around the designer's neck. Conventional configurations—rigid paddles that pop out after launch, or cells mounted around the satellite's body—can no longer handle the additional power needs. Work is accelerating on both sides of the Atlantic in the search for lighter and more compact arrays.

The idea—being pursued in the U.S. by such aerospace companies as TRW Systems, Clevite, and Ryan—is to mount thinner cells on light, flexible systems that will fold or roll out of the way during launch. U.S. work is aimed primarily at more power; the British at less size and weight—as in small satellites carrying one array weighing roughly 50 pounds and generating a kilowatt or more. Such an output would require about 140 pounds if the cells were paddle-mounted.

Lower output. Britain's work is being carried on at the Royal Aircraft Establishment. At last week's IEEE Photovoltaic Conference at Pasadena, Calif., the RA£'s Roy Crabb and Fred Treble described a system of flexibly mounted thin silicon cells that has reached the ground-test model stage. Ferranti Ltd. has made about 1,000 of the cells and has approved yield and practicality even though thin cells cost more than thick ones.

The cells, 125 microns thick and 2 centimeters square, have lower electrical outputs than their thick cousins because photons at red and infrared wavelengths pass right through them. However, say Crabb and Treble, the power-weight ratio is about three times higher. What's more, they add, the output of both types is the same toward the end of their lives.

The thin cells use standard thick-cell n-on-p construction. The resistivity of the base is 10 ohm centimeters and the junction depth about 0.25 microns. Ferranti believes it will be able to get satisfactory yields with a top output of 12 milliwatts per square centimeter at 30°C, degrading to 11 mw after bombardment equivalent to 10¹⁶ electrons per square centimeter at 1 megaelectron-volt. That, presumably, would be the condition of the cells after several years of orbit through the Van Allen Belt.

Higher cost. Made of oxygen-lean float-zone silicon, the cells are more expensive than those made of the high-oxygen silicon generally used in the U.S. However, say Crabb and Treble, they last longer, and a ceric-oxide coating keeps reflection losses down to 1%, com-
pared with 5% for the silicon monoxide used in the U.S. to cut reflection loss.

The sum of the two innovations, say the Britons, is maximum cell efficiency of about 9% at the mean solar constant of 140 mw per square centimeter. This would degrade, at the stated bombardment rate, to 8.2%. This compares to the 4% to 5% efficiency obtained by U.S. researchers working with thin-film polycrystalline cadmium sulfide and cadmium telluride cells.

The RAE-Ferranti cells are mounted on a light substrate of Du Pont’s Kapton polyimide film 30 microns thick. The cells are in two parts, each folded accordion-fashion and attached to a telescoping mast. Each fold contains three rows of cells, which are protected during launch by interleaved thin plastic sheets that stay behind when the cells are freed.

Reins damp tv outlook

As if British television-set makers didn’t have enough problems with lagging color sales, they’ve now been hit by tighter credit regulations. The government has increased the minimum down payment and cut the maximum repayment period on all consumer goods.

The blow came at a particularly bad time. The color market has been in the doldrums, largely because the average receiver costs about $700 and only one channel offers color programs. Since last summer, though, makers and renters have been stockpiling sets with an eye to increased winter sales. But it looks as though the stiffer credit rules will remain in force at least until next spring—the start of the slack season. What it all boils down to is that sales will probably crawl along at their present pace until next fall, when color transmission starts on Britain’s other two channels.

The black-and-white picture is a bit brighter, however. Paradoxically, sales increased through the summer and most manufacturers have a backlog of orders.

West Germany

Feeling the heat

Automotive engineers seeking to improve engine designs must know the temperatures developed by the pistons. But methods used to date have been cumbersome, time consuming, and—most important—inaccurate. For instance, one technique calls for the insertion of metal plugs with different melting points in holes bored in the piston wall; the engine is then taken apart after each run to see which plugs have melted. The result is only a ±10°C approximation of the temperatures.

The primitive state of this art prompted the Institute for Automotive Engineering at West Germany’s University of Aachen to apply some familiar electronic principles to the problem. The result is a test system that’s faster and more accurate than anything used to now, and that eliminates any need to take the engine apart or to apply contacts while it’s running.

Warming up. The technique employs negative-temperature-coefficient semiconductor elements as sensing devices, plus a set of coils. Circuit values that are a function of temperature are transmitted to a meter by the coils. Using the university’s development, a piston manufacturer, Karl Schmidt GmbH, has put together a system that can determine piston-wall temperatures to within 1° to 2.5°C and can handle inputs from as many as 10 spots around the piston simultaneously.

The elements are placed in small holes drilled into the piston’s inner wall, with high-temperature paste insuring good contact between element tips and metal. The leads run along the inner wall to an air-core coil attached to the lower part of the piston. As the piston comes down to its dead point, the air-core coil caps a smaller ferrite-core coil fixed to the bottom of the engine block.

A 456-kilohertz voltage is applied across both a series resistance and the ferrite-core coil. When that coil meets the air-core coil, the negative-temperature-coefficient resistance causes temperature-dependent attenuation in the coils’ circuits, changing both the current in the ferrite-core coil and the voltage across the series resistance.

Option. Since the resistance of the negative-temperature-coefficient element declines as temperature rises—causing attenuation to increase—the voltage across the series resistance rises. That voltage is picked off, rectified, and fed to a peak-value measuring device with a d-c amplifier. The amplified signal is then applied to a moving-coil temperature indicator; it can also be fed to a temperature

Hot rod. This system developed at the University of Aachen accurately measures the temperature of engine pistons.
On the spot

Any electronics production engineer knows that one of the most vexing and tedious jobs is wiring big patch panels, plug boards, and similar assemblies with a large number of terminals. Workers must look up terminal numbers on a drawing or wiring list, pinpoint the corresponding spots on the work piece, and then make the connection. That done, wires have to be "run out" for continuity—and all too often reconnected because of errors.

Eliminating the drudgery in such work is what AEG-Telefunken has in mind with semiautomatic equipment it has just put on the market. In the equipment, slightly larger than a teletypewriter, an optical system produces a light dot that spots the correct terminal, thus telling the assembler where the connection must be made. The dot moves, according to information punched out on tape, and the lead is automatically checked out when the connection is made.

The equipment spells big savings in labor: three girls—one at the machine and two for preparing the leads—do the work of 14, a distinct advantage in West Germany’s labor-short economy. What’s more, the chance of wiring a lead to the wrong spot is less than one in about 14,000.

No parallax. Originally developed by Telefunken for its own use, the setup, called TAV, will be marketed by Amphenol-Tuchel Electronics GmbH, a subsidiary of the Amphenol Corp. It will sell for about $30,000.

In a typical wiring job, the terminal board or frame is put into an adapter at the front end of the setup. The information for the equipment’s control system comes from a reader that scans the terminal address punched out on eight-track paper or metallized plastic tape. After the address is stored the control unit stops the reader and triggers the optical indicating system. That system produces the light dot and steers it vertically and horizontally to the designated spot. The dot is produced in a glass panel installed above the terminal board; it is seen as a parallax-free reflection.

The connection tool also serves as a test probe. If the wire continuity test is positive, the control unit advances the punched tape so that the next terminal address can be read. If the test is negative the control unit fails to operate.

Japan

Steady gains

Designing hybrid integrated-circuit amplifiers for S-band operations is a ticklish proposition because the transistors must work in a range close to f,—the frequency at which input gain equals output gain in a common emitter. Gain at these frequencies falls at a rate of about 6 decibels per octave, making it difficult to maintain a constant gain value over a wide band.

The usual solution is to design the amplifier so that the transistors reflect some of the input power at the lower frequencies and are properly matched to circuits at the higher frequencies. But unless each stage is isolated, such matching can raise havoc with the circuits connected to the amplifier and thwart efforts to cascade several stages for increased gain.

Another road. Engineers at the Nippon Electric Co. rejected that method—and Bell Labs’ use of two very closely matched transistors per stage—in building a simple i-f amplifier to be used in a receiver they’ve developed for a millimeter-wave pulse-code-modulation system [Electronics, Sept. 30, p. 209]. Their amplifier has transistors with a gain of about 4 db per stage over a frequency range of 3.5 to 4.3 gigahertz. It can be used as a substitute for low-power traveling-wave or triode amplifiers in a 4-GHz microwave relay station, as a pre-

Light work. AEG-Telefunken's semiautomatic wiring equipment has a connection tool that won't go on to next step if all isn't well.
amp in microwave test equipment, or as the i-f amplifier in wideband millimeter-wave communications systems.

Both the Nippon Electric and Bell amplifiers are built with strip-line having a 50-ohm impedance. But the Japanese technique eliminates transistor matching as well as any need for a three-dimensional coupler circuit within the ½-inch space between the triplate's two ground planes—another feature of the Bell scheme.

To keep the gain constant across the band (by increasing reflection at lower frequencies), the Japanese engineers paid a price they feel they can afford: the standing-wave ratio, especially at the input, increases as frequency decreases. This means that though the gain is constant, large ripples would be introduced into the gain's characteristic if several stages were cascaded.

Follow the line. One answer to the problem would be isolators between stages, but this method is costly and cumbersome. Instead, Nippon Electric researchers have inserted lengths of line between stages to introduce a phase shift that cancels the effects of reflections. The company claims that a quarter-wavelength line between the second and third stages of a three-stage amplifier does the trick.

There was yet another hurdle—the considerable variations in the standing-wave ratios between input at the first stage and output at the third. The solution: an isolator composed of yttrium iron garnet disks above and below the circuit. This isolator has a bandwidth exceeding 1 Ghz in the 4-Ghz band, and a unity standing-wave ratio of less than 1.2. Isolation is more than 20 db, and insertion loss is below 0.4 db.

Calculating components

When electronic desk calculators become Japan's biggest market for integrated circuits—as they will within a few years—the marketplace will be crowded. The country's electronics giants have been busily designing such IC's for the past several years. The latest to be announced are 64-bit and 60-bit shift registers and a full adder/subtractor with carry/borrow output, all from Toshiba.

The adder/subtractor uses metal oxide semiconductor exclusive-OR circuits for simplicity and better logic configuration. In fact, of the three current approaches to a full adder/subtractor for desk calculators, only the MOS IC needs just one package. By contrast, 64 devices are needed when only discrete components are used, and diode-transistor-logic IC's requires eight packages.

Elementary. Comparing the number of elements in each package reveals a similar pattern. The discrete contains 64 elements, the DTL 144, and Toshiba's new MOS version but 39. This simplicity is rooted in the exclusive-OR circuit, which requires only three MOS field effect transistors and correspondingly fewer elements throughout. Besides elements for the adder/subtractor, the die contains a flip-flop to generate a one-bit delayed carry. The die is approximately 1/16th inch square.

As to the shift registers, the 64-bit version contains about 440 elements on one die.

One of the more important shift-register parameters for desk-calculator designers is the minimum operational clock frequency. Toshiba's units can operate at frequencies about 1/7th to 1/10th the minimums for similar circuits, or 22.5 hertz at 75°C. The reason: a lower leakage current and longer time constant.

Around the world

Central America. The five member nations of the technical commission on telecommunications for Central America have agreed to study the plan for a regional two-satellite communications network proposed by Honduras [Electronics, March 18, p. 244]. The satellites would provide a link with the U.S. and Europe. The states—the other four are Costa Rica, Nicaragua, El Salvador, and Guatemala—also agreed to postpone from November 29 until January 15 the opening of bids on a regional non-satellite communications network.
In hope of doing each other some good

Rising tide of mesomorphics

Imaginative people get excited over liquid crystals. This category of people includes optical physicists, artists, analytical chemists, aerospace engineers, dermatologists, designers of integrated electronic circuits, contestans in science fairs, biophysicists, osmosiologists, welding engineers, and entrepreneurs who think it is still not too late to make a bundle by interesting the human female in body paint. Unimaginative people believe the word “fraught” is being overused. They may regret their attitude, or they may not.

Meanwhile, there must be almost as many laboratories either guarding or disclosing liquid crystal secrets as are working on holograms. With which the mesomorphic, or liquid crystal, state has no connection. Or does it?

A fraught statement enunciates the liquid crystal principle and why we bring it up: The liquid crystal state is the opposite of the glassy state in the sense that glass is rigid but unordered, while the following become highly ordered even when soft as an unguent:

<table>
<thead>
<tr>
<th>EASTMAN Cholesteric Mixture Solution No.</th>
<th>for temperature range</th>
</tr>
</thead>
<tbody>
<tr>
<td>A10629</td>
<td>12-17°C</td>
</tr>
<tr>
<td>A10630</td>
<td>16-19</td>
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<tr>
<td>A10631</td>
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<tr>
<td>A10632</td>
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<td>A10668</td>
<td>41-42</td>
</tr>
<tr>
<td>A10670</td>
<td>43-44</td>
</tr>
</tbody>
</table>

These believed of most immediate practical application for thermographic mapping of a surface within each range indicated. With No. A10650, for example, you get no information about areas cooler than 34°C or warmer than 35°C, but you ought to be able to spot variations within that one-degree span from an iridescent blue appearance at 35 through a gamut of color to a red at 34. Order any of them at $25 for 100 ml from Distillation Products Industries, Rochester, N.Y. 14603 (Division of Eastman Kodak Company). Blacken surface, spray on, let evaporate

If no temperature range here listed fits proposed use, or if price seems discouraging for application from a big hose, inquire anyway. We pride ourselves on a practical outlook.

Whatever else you see here, you are looking at a result of advanced technology with fibers.* The garment and home-furnishings industries are not the only customers for fiber technology. To fabricators of artificial eyes we have been furnishing vein- and artery-like colored fibers. More complex projects seem even more exciting commercially. Papermakers ourselves for photographic applications, we have been talking and working a bit with other papermakers, who, as major users of fibers, have been attracted to Kodel Polyester Fiber. And aside from fibers themselves, the technology of fibers-handling seems to have some useful contributions to make to electrical-electronic technology in the matter of winding and insulating components.

Anna Griffin, Vice President/Fibers, Eastman Chemical Products, Inc. (Subsidiary of Eastman Kodak Company), Kingsport, Tenn. 37662 seeks new friends.

*In this case with our Verel Modacrylic Fiber—as put by North Bay into something a kind, animal-loving lady can appreciate. With the gift season perilously close there may still be time to let the list of ladies to look for at the local shopping center by writing Knit Merchandising Department at Eastman Chemical Products, Inc., 260 Madison Avenue, New York City 10016.

In contact with the film

Only modest skills in persuasion are needed to get an engineer to grant that photography on a continuous reel of film has attractive advantages in keeping watch on objects and scenes, in digital recording, or in recording analog signals with high-frequency components. Stronger talent is often needed to convince him that the advantages are worth the price in fuss, delay, and the need for expertise with solutions and the temperature thereof. Now the price has come down.

Kodak Bimat Transfer Film, originally devised to process film unattended inside a satellite, is now available in four commercial forms. When this film (which is not light-sensitive itself) is brought into proper contact with film on which your desired image has been exposed, the Bimat Film turns within seconds into a high-quality positive and the original film into an even better-quality negative. They can be left in contact for minutes or hours with little visible difference in effect on results. Subsequent conventional treatment is necessary only if the negative or positive is to be kept for long periods of time. The system works with numerous taking films that have been on the market for some time. Also on the market—but not from us—is equipment, simple and compact, for bringing the films together and separating them. Equipment manufacturers who furthermore think the market will reward good designs for continuous processing by this method can expect plenty of technical encouragement from us.

Let us be realistic, however. In order to give this thing the commercial viability it seems to deserve, we need to find people who can use the four existing kinds of Kodak Bimat Transfer Film and to put those people in good contact with the product. A careful plan to achieve this has been thought out by R. T. Lassiter, Mail Code 942, Eastman Kodak Company, Rochester, N.Y. 14650, who eagerly awaits mail.

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As a four-bit adder, the 8260 permits parallel addition of four sets of data and features simultaneous I/O switchability carry on each bit within the package. Extension of the look-ahead feature for 16 bits or more is facilitated by the 8261 Fast Carry Extender.

Access to the 8260 from previous stages is provided through five OR-ed channels, and inhibition of carry-in data and bit-to-bit carries is accomplished by a true (active high) logic level of CINH.

The 'carry-outs' available are: Internally Generated (C0), Propagated (Cp), and Ripple (Cq). This gives the 8260 complete flexibility when used in Ripple Carry or Anticipated Carry Adder systems.

The 8260 is available now in 24-lead flat pack, −55 °C to +125 °C and 0 °C to +75 °C, and will soon be available in both full MIL and commercial DIPs.

For complete information on the world’s fastest adder write Signetics, 811 East Arques Avenue, Sunnyvale, California 94086. Fast!
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